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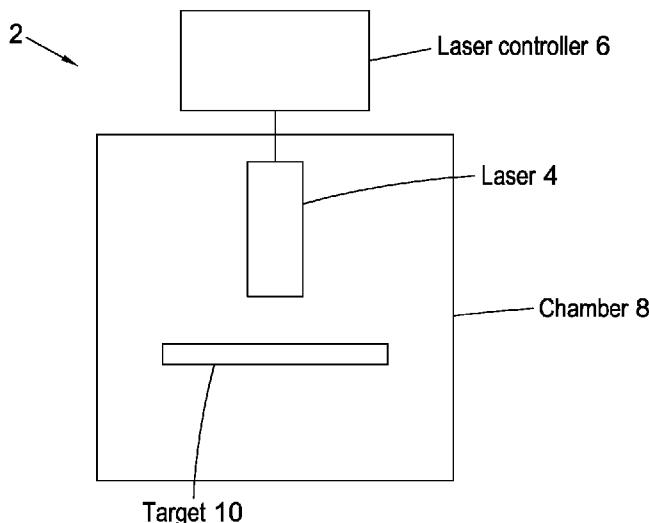
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## (54) Title: METHOD OF REDUCING PHOTOELECTRON YIELD AND/OR SECONDARY ELECTRON YIELD OF A CERAMIC SURFACE; CORRESPONDING APPARATUS AND PRODUCT



(57) Abstract: A method of reducing photoelectron yield (PEY) and/or secondary electron yield (SEY) of a ceramic surface comprises applying pulsed laser radiation comprising a series of laser pulses emitted by a laser (4) to the surface of a target (10) to produce a periodic arrangement of structures on the surface of the target (10).

Fig. 1



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## METHOD OF REDUCING PHOTOELECTRON YIELD AND/OR SECONDARY ELECTRON YIELD OF A CERAMIC SURFACE ; CORRESPONDING APPARATUS AND PRODUCT

The present invention relates to methods of, and apparatus for, processing ceramic surfaces

5 in order to reduce photoelectron yield (PEY) and/or secondary electron yield (SEY).

### BACKGROUND

Photoelectron emission (PEE) refers to the emission of electrons due to interaction of

10 photons with a surface. Secondary electron emission (SEE) refers to emission of a secondary electron from a surface due to interaction of a primary electron with the surface.

Photoelectron yield (PEY) can be used to characterise PEE and secondary electron yield (SEY) can be used to characterise SEE. PEY and SEY may be taken to be the average number of emitted electrons per single incident photon or electron respectively.

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PEE and SEE effects can cause significant difficulties in a wide variety of apparatus, for

example in particle accelerators, beamlines, waveguides, for example r.f. waveguides, detectors, spacecraft, and vacuum chambers. PEE and SEE effects can lead, variously, to

20 undesired electron cloud build-up, undesired increases in pressure, beam losses and instability, reduction in beam lifetimes, undesired heat loads, power loss, damage, reduction in apparatus lifetime, increase in noise, and decrease in sensitivity, depending on the particular type of apparatus and application in question.

The reduction of SEY or PEY for ceramic materials, such as > 99.5 % pure aluminium oxide

25 (alumina), for example 99.7% pure alumina used for Kickers in accelerator beam transfer (Injection Kicker Systems) can be particularly challenging as, for example, SEY values may be significantly higher (for example 8 or above) than desired for some practical applications (for example less than 2, or less than 1.6 or even 1.4 in some cases). Although  $Al_2O_3$  is generally referred to as aluminium oxide or alumina, it is also known in the art to refer to it as

30 alumina oxide.

It is desired to provide improved or at least alternative methods for reducing PEY and SEY.

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## SUMMARY

In a first aspect of the invention there is provided a method of reducing photoelectron yield

(PEY) and/or secondary electron yield (SEY) of a ceramic surface, comprising applying laser

5 radiation to the surface to produce a periodic arrangement of structures on the surface.

The laser radiation may comprise pulsed laser radiation comprising a series of laser pulses.

A ceramic material, for example the ceramic surface, may comprise metallic and non-metallic atoms joined by ionic bonds and/or covalent bonds, for example a mixture of ionic

10 bonds and covalent bonds.

The power density of the laser radiation, for example of the pulses, may be in the  $\text{TW}/\text{cm}^2$

range, optionally in a range  $0.1 \text{ TW}/\text{cm}^2$  to  $3 \text{ TW}/\text{cm}^2$ . Optionally the power density may be in

a range  $0.5 \text{ TW}/\text{cm}^2$  to  $1.5 \text{ TW}/\text{cm}^2$ .

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Alternatively, power density of the laser radiation, for example of the pulses, may be in the  $\text{GW}/\text{cm}^2$  range, optionally in a range  $0.1 \text{ GW}/\text{cm}^2$  to  $3 \text{ GW}/\text{cm}^2$ . Optionally the power density may be in a range  $0.2 \text{ GW}/\text{cm}^2$  to  $1 \text{ GW}/\text{cm}^2$ .

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By using laser pulses having such power densities in the  $\text{TW}/\text{cm}^2$  range or in the  $\text{GW}/\text{cm}^2$  range, a periodic arrangement of structures that provides a surface with desired electron work function properties may be obtained. For example a surface having a desired value or range of values of secondary electron yield (SEY) may be obtained.

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The method may alter the properties of surface such that the surface has a value of SEY less than 2.5, optionally less than 2.0, optionally less than or equal to 1.6, optionally less than or equal to 1.4, optionally in a range 0.2 to 2.0, optionally in a range 0.5 to 1.6, optionally in a range 1.0 to 1.4.

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The laser pulses may have a duration less than a thermal relaxation time of the material of the surface. The laser pulses may have a duration such that the electrons and the atomic lattice of the material of the surface have a substantially different temperature substantially throughout application of the laser pulses. The laser pulses may have a duration such that material of the surface is at least one of evaporated or vaporised or removed without substantial melting and/or flowing of the surface. The laser pulses may have a duration such

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that some material of the surface is at least one of evaporated or vaporised or removed without substantial melting and/or flowing of the remaining material of the surface.

5 A pulse duration of the laser pulses may be in a range 300 femtoseconds (fs) to 1 nanosecond (ns).

A pulse duration of the laser pulses may be in a range 1 ns to 100 ns.

10 The periodic arrangement of structures on the surface may comprise a periodic series of peaks and troughs substantially parallel to each other, and the peaks may be substantially flat on top and/or may be rounded on top and/or may have substantially no pointed and/or or sharp regions on top. The peaks may substantially have a top hat shape and/or a truncated pyramidal shape, for example a top hat shape and/or a truncated pyramidal shape in cross-sectional profile. Thus, for example, a desired value of electron work function and/or desired 15 electron trapping properties may be obtained. The peaks may extend in a longitudinal direction and may be referred to as ridges.

20 The peak to trough distance for at least some of the peaks, and/or an average or median peak to trough distance, may be in a range 1  $\mu\text{m}$  to 100  $\mu\text{m}$ , optionally in a range 20  $\mu\text{m}$  to 80  $\mu\text{m}$ , optionally in a range 30  $\mu\text{m}$  to 60  $\mu\text{m}$ .

25 The periodic arrangement of structures may comprise a cross-hatched arrangement or an arrangement of substantially parallel lines of peaks and troughs (for example, ridges and valleys) substantially without cross-hatching. The periodic arrangement of structures may, for example, be produced by a single pass of a laser source that provided the laser radiation.

The ceramic surface may be on an at least one underlying layer and the laser radiation may be such as to substantially not remove or move material of the surface in such a way as to expose the underlying layer.

30 In a further aspect of the invention, which may be provided independently, there is provided a ceramic laser treated surface comprising a laser-formed periodic arrangement of structures on the ceramic surface, wherein at least one of:

35 the periodic arrangement of structures comprises a periodic series of peaks and troughs substantially parallel to each other;

the periodic arrangement of structures comprises a cross-hatched, periodic series of peaks and troughs; and optionally

the peaks may be substantially flat on top and/or may be rounded on top and/or may have substantially no pointed and/or or sharp regions on top and/or the peaks may 5 substantially have a top hat shape and/or a truncated pyramidal shape, for example a top hat shape and/or a truncated pyramidal shape in cross-sectional profile; and/or

the peak to trough distance for at least some of the peaks, and/or an average or median peak to trough distance, may be in a range 1  $\mu\text{m}$  to 100  $\mu\text{m}$ , optionally in a range 20  $\mu\text{m}$  to 80  $\mu\text{m}$ , optionally in a range 30  $\mu\text{m}$  to 60  $\mu\text{m}$ .

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In a further aspect of the invention, which may be provided independently, there is provided an apparatus for reducing photoelectron yield (PEY) and/or secondary electron yield (SEY) of a ceramic surface, comprising:

a laser source for applying pulsed laser radiation to a surface; and

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a laser controller configured to control the laser source to apply the laser radiation as a series of laser pulses thereby to form a periodic arrangement of structures on the surface. The power density of the pulses may be in the  $\text{TW}/\text{cm}^2$  range or in the  $\text{GW}/\text{cm}^2$  range. The power density of the pulses may be a range 0.1  $\text{TW}/\text{cm}^2$  to 3  $\text{TW}/\text{cm}^2$ . The power density of the pulses may be a range 0.1  $\text{GW}/\text{cm}^2$  to 3  $\text{GW}/\text{cm}^2$ .

20

In a further aspect of the invention, there is provided a method of reducing photoelectron yield (PEY) and/or secondary electron yield (SEY) of a ceramic surface, comprising:

applying laser radiation to the surface to produce a periodic arrangement of structures on the ceramic surface, wherein

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the laser radiation comprises pulsed laser radiation comprising a series of laser pulses, and a pulse duration of the laser pulses is in a range 300 fs to 1 ns or in a range 1 ns to 100 ns.

The surface may be the surface of a target.

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The pulse duration may be in a range 1 ps to 100 ps. The pulse duration may be in a range 1 ps to 50 ps. The pulse duration may be in a range 5ps to 500 ps

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The laser radiation may comprise a pulsed laser beam that has a focal spot diameter on the surface in a range 5  $\mu\text{m}$  to 100  $\mu\text{m}$  or in a range 1  $\mu\text{m}$  to 100  $\mu\text{m}$ .

The pulsed radiation may have a pulse repetition rate in a range 10 kHz to 1 MHz, optionally in a range 10 KHz to 200 kHz.

- 5 An average power of the laser radiation may be in a range 3W to 8W or in a range 1W to 10W. An average power of the laser radiation may be in a range 0.3 W to 2W, or in a range 1 W to 5 W, or in a range 0.1 W to 1 W, or in a range 0.1 W to 2 W, or in a range 0.3W to 5W.
- 10 The applying of the laser radiation to the surface may comprise scanning a pulsed laser beam over the surface, and a scan speed for the scanning may be in a range 1 mm/s to 100 mm/s or in a range 10 mm/s to 50 mm/s.

15 The scanning of the pulsed laser beam over the surface may be repeated between 2 and 10 times, or may be performed once.

An angle of incidence of the laser radiation to the surface may be in a range from 0 to 30 degrees. The angle of incidence of the laser radiation to the surface may be in a range from 90 degree to 60 degrees.

20 A wavelength of the radiation may be in a range 100 nm to 2,000 nm, optionally 355 nm or 532 nm or 1064 nm.

25 The structures may comprise peaks and troughs. The periodic arrangement of structures may comprise a periodic series of peaks and troughs. The peaks and troughs may be substantially parallel to each other.

30 The periodic arrangement of structures may comprise a first series of peaks and troughs arranged in a first direction, and a second series of peaks and troughs arranged in a second, different direction. The first and second directions may be substantially orthogonal. The first series of peaks and troughs and the second series of peaks and troughs may intersect such that the periodic arrangement of structures comprises a cross-hatched arrangement.

35 A period of the periodic arrangement may be in a range 0.5  $\mu$ m to 100  $\mu$ m. The separation of adjacent peaks (or troughs) of the periodic structure may be in a range 0.5  $\mu$ m to 100  $\mu$ m.

A hatch distance of the cross-hatched arrangement may be in a range 0.5  $\mu\text{m}$  to 100  $\mu\text{m}$ , optionally in a range 10  $\mu\text{m}$  to 100  $\mu\text{m}$ .

5 The laser radiation may be such that the applying of the laser radiation to the surface comprises producing further structures. The further structures may be smaller than the structures of the periodic arrangement of structures.

10 That feature may be particularly important, so in a second aspect of the invention, which may be provided independently, there is provided a method of reducing photoelectron yield (PEY) and/or secondary electron yield (SEY) of a ceramic surface, comprising:

applying laser radiation to the surface to produce a periodic arrangement of structures on the surface, wherein

15 the laser radiation comprises pulsed laser radiation comprising a series of laser pulses, and the laser radiation is such as to produce further structures on the surface as well as the periodic arrangement of structures.

20 The further structures may comprise further periodic structures. The further structures may comprise ripples. The further structures may comprise nano-ripples. The further structures may be further periodic structures. The further structures may comprise laser induced periodic surface structures (LIPPS), for example with periodicity in the range of the laser wavelength. The further structures may have a periodicity in a range 10 nm to 1  $\mu\text{m}$ , optionally in a range 100 nm to 1  $\mu\text{m}$ .

25 The further structures may cover at least part of the periodic array of structures. The further structures may be formed in the troughs and/or on the peaks of the periodic arrangement of structures.

30 The ceramic surface and/or target may comprise alumina. For example, > 99.5 % pure alumina oxide used for Kickers in accelerator beam transfer (Injection Kicker Systems).

35 The ceramic surface and/or target may comprise any suitable magnetic, conductive or dielectric ceramic material.

The surface and/or target may comprise a ceramic material having a spinel structure, for instance a spinel structure having the formula  $\text{M}(\text{Fe}_2\text{O}_4)$  where  $\text{M}$  is a covalent cation.  $\text{M}$

may be a covalent cation selected from the group manganese ( $Mn^{2+}$ ), nickel ( $Ni^{2+}$ ), cobalt ( $Co^{2+}$ ), zinc ( $Zn^{2+}$ ), copper ( $Cu^{2+}$ ), magnesium ( $Mg^{2+}$ ). Alternatively M may represent a monovalent cation, for example lithium ( $Li^+$ ) or even a vacancy or vacancies, for instance in the case where such absences of positive charge may be compensated for by additional 5 trivalent iron cations ( $Fe^{3+}$ ).

The surface and/or target may comprise a ferrite material, for example a hexagonal ferrite material, for instance a material having a structure  $M(Fe_{12}O_{19})$ . M may be selected from the group barium (Ba), strontium (Sr), lead (Pb).

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The surface and/or target may comprise a garnet ferrite material, for instance having the structure of the silicate mineral garnet, and for example having the chemical formula  $M_3(Fe_5O_{12})$  where M may be yttrium or a rare earth ion.

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The surface and/or target may comprise a thick- or thin-film resistor or electrode or capacitor or a material that may be suitable for use as or as part of such thick- or thin-film resistor or electrode or capacitor. The surface and/or target may comprise a metal oxide material, for instance a material selected from the group, lead oxide ( $PbO$ ), ruthenium dioxide ( $RuO_2$ ), bismuth ruthenate ( $Bi_2Ru_2O_7$ ). The surface and/or target may comprise a ceramic material 20 having overlapping energy bands.

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The surface and/or target may comprise a ceramic conductor. For instance, the surface and/or target may comprise indium oxide ( $Ind_2O_3$ ) and/or tin oxide ( $SnO_2$ ) or indium tin oxide (ITO).

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The surface and/or target may comprise a heating element or a material that may be suitable for use as or as part of such a heating element. The surface and/or target may comprise material selected from the group silicon carbide ( $SiC$ ), molybdenum disilicide ( $MoSi_2$ ), lanthanum chromite ( $LaCr_2O_4$ ), zirconia ( $ZrO_2$ ).

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The surface and/or target may comprise a thermistor or a material that may be suitable for use as or as part of such a thermistor. The surface and/or target may comprise material selected from the group consisting of iron spinel material, cobalt spinel material and manganese spinel material.

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The surface and/or target may comprise a superconductor material, for example yttrium barium copper oxide ( $\text{YBa}_2\text{Cu}_3\text{O}_7$ ), a bismuth-strontium-calcium-copper oxide material (for example  $\text{Bi}_2\text{Sr}_2\text{CuO}_6$ ,  $\text{Bi}_2\text{Sr}_2\text{CaCu}_2\text{O}_8$ , or  $\text{Bi}_2\text{Sr}_2\text{Ca}_2\text{Cu}_3\text{O}_{10}$ ), a thallium-barium-calcium-copper oxide material (for example  $\text{Tl}_2\text{Ba}_2\text{CuO}_6$ ,  $\text{Tl}_2\text{Ba}_2\text{CaCu}_2\text{O}_8$ ,  $\text{Tl}_2\text{Ba}_2\text{Ca}_2\text{Cu}_3\text{O}_{10}$ , or 5  $\text{TlBa}_2\text{Ca}_3\text{Cu}_4\text{O}_{11}$ ) or a mercury-barium-calcium-copper oxide material (for example  $\text{HgBa}_2\text{CuO}_4$ ,  $\text{HgBa}_2\text{CaCu}_2\text{O}_6$ , or  $\text{HgBa}_2\text{Ca}_2\text{Cu}_3\text{O}_8$ ).

The surface and/or target may comprise a perovskite material. The surface and/or target may comprise barium titanate ( $\text{BaTiO}_3$ ) or barium titanate including non-stoichiometric lead, 10 strontium or calcium substitutions.

The surface may form part of a laminated structure, for example a laminated target, for instance comprising alumina and at least one other material.

15 An average or peak fluence or other property of the laser radiation may be above an ablation threshold, and/or in the range of thermal threshold of the surface and/or within 105%, optionally 102%, optionally 101% of the ablation threshold.

The pulses may be such that, for each pulse, a plasma is formed at the surface. The plasma 20 may have substantially the same density as underlying material of the surface.

The surface may form part of a particle accelerator, an injection kicker system, a beamline, a waveguide for example an r.f. waveguide, a detector, a detector apparatus, or a spacecraft.

25 The surface may comprise or form part of a surface of a vacuum chamber.

The surface may comprise a surface of a component of an apparatus. The apparatus may be selected from: a particle accelerator, a beam kicker magnet (the component may for example comprise a ceramic plate capacitor or ceramic liner pipe), a beamline, a waveguide 30 for example an r.f. waveguide, a detector, a detector apparatus, a spacecraft. The method may comprise applying the laser radiation to the surface to produce the periodic arrangement of structures on the surface and then installing the component in the apparatus, or the method may comprise applying the laser radiation to the surface with the component in situ in the apparatus.

The method may comprise applying the radiation using a pulsed solid-state bulk laser, optionally the solid state laser comprises a Nd:YVO<sub>4</sub> or Nd:YAG or Yb:KYW or Yb:KGW laser, or a pulsed fibre laser, optionally a Yb, Tm or Nd – doped pulsed solid-state fibre laser.

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The method may comprise forming a metal layer on at least part of the surface after the applying of the laser radiation.

The method may comprise substantially covering the periodic structures with the metal layer.

10 The metal layer may be formed using any suitable process, for example a coating process.

The metal layer may comprise gold or any other suitable metal, for example silver, copper or aluminium. The metal layer may comprise elemental metal, for example elemental gold, silver, copper or aluminium, or may comprise a metal alloy or metallic compound.

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The metal layer may have a thickness in a range 0.1 nm to 100 nm, optionally 1 nm to 50 nm, optionally 1 nm to 20 nm. The metal layer may have a substantially constant thickness.

The metal layer may have a thickness such as to maintain the morphology of the surface, for example to maintain the surface to have substantially the same cross-sectional profile as

20 before the formation of the metal layer. For instance the metal layer may have a thickness such as to maintain substantially the same distribution of laser-formed troughs and peaks at the surface as before the formation of the metal layer, and/or such as to not completely fill in gaps between surface features, for example the troughs and/or peaks or other laser-formed surface features.

25

The method may comprise at least one of degreasing, cleaning or smoothing the surface after the applying of the laser radiation and/or performing a surface carbon reduction process with respect to said surface after the applying of the laser radiation.

30 In a further aspect of the invention, which may be provided independently, there is provided an apparatus for reducing photoelectron yield (PEY) and/or secondary electron yield (SEY) of a surface, comprising:

a laser source for applying pulsed laser radiation to a surface; and

a laser controller configured to control the laser source to apply the laser radiation as a series of laser pulses having a pulse duration in a range 200 femtoseconds (fs) to 1000 ps, so as to produce a periodic arrangement of structures on the surface.

5 In a further aspect of the invention, which may be provided independently, there is provided an apparatus for reducing photoelectron yield (PEY) and/or secondary electron yield (SEY) of a ceramic surface, comprising:

a laser source for applying pulsed laser radiation to a surface and configured to operate so as to perform a method according to any other aspect.

10

In a further aspect of the invention, which may be provided independently there is provided a laser treated ceramic surface comprising a periodic arrangement of structures on the surface formed using a method according to any other aspect.

15 The surface may further comprise a metal layer covering at least part, optionally substantially all, of the periodic arrangement of structures and/or of the surface. Thus, at least part optionally all of the outer part of the ceramic surface may comprise metal.

20 In a further aspect of the invention, which may be provided independently, there is provided a laser treated ceramic surface comprising a laser-formed periodic arrangement of structures on the ceramic surface and further laser-formed structures on the ceramic surface.

25 The further structures may comprise further periodic structures. The further structures may comprise ripples. The further structures may comprise nano-ripples. The further structures may be further periodic structures. The further structures may comprise laser induced periodic surface structures (LIPPS). The further structures may have a periodicity in a range 10 nm to 1  $\mu$ m, optionally in a range 100 nm to 1  $\mu$ m.

30 The structures may comprise peaks and troughs. The periodic arrangement of structures may comprise a periodic series of peaks and troughs. The peaks and troughs may be substantially parallel to each other.

35 The periodic arrangement of structures may comprise a first series of peaks and troughs arranged in a first direction, and a second series of peaks and troughs arranged in a second,

different direction. The first and second directions may be substantially orthogonal. The first series of peaks and troughs and the second series of peaks and troughs may intersect such that the periodic arrangement of structures comprises a cross-hatched arrangement.

5 A period of the periodic arrangement may be in a range 0.5  $\mu\text{m}$  to 100  $\mu\text{m}$ . The separation of adjacent peaks (or troughs) of the periodic structure may be in a range 0.5  $\mu\text{m}$  to 100  $\mu\text{m}$ . A hatch distance of the cross-hatched arrangement may be in a range 0.5  $\mu\text{m}$  to 100  $\mu\text{m}$ .

10 The further structures may comprise further periodic structures. The further structures may comprise ripples. The further structures may comprise nano-ripples. The further structures may be further periodic structures. The further structures may comprise laser induced periodic surface structures (LIPPS). The further structures may have a periodicity in a range 10 nm to 1  $\mu\text{m}$ , optionally in a range 100 nm to 1  $\mu\text{m}$ .

15 The further structures may cover at least part of the periodic array of structures. The further structures may be formed in the troughs of the periodic arrangement of structures.

20 The surface may comprise alumina. The surface may form part of a laminated structure, for example a laminated target, for instance comprising alumina or other ceramic and at least one other material.

In a further aspect of the invention, which may be provided independently, there is provided a method of modifying a ceramic surface by applying laser radiation to the surface to modify the surface by way of a photo-thermal interaction and/or a photo-ablation interaction.

25 In another aspect of the invention, which may be provided independently, there is provided a ceramic surface modified by way of a photo-thermal interaction and/or a photo-ablation interaction obtained by applying laser radiation to the surface.

30 In a further aspect of the invention, which may be provided independently, there is provided a particle accelerator, an injection kicker system, a beam kicker magnet, a beamline, a waveguide, a detector, a spacecraft, or a vacuum chamber that includes a component having a ceramic surface according to any of the other aspects or formed according to any of the other aspects.

In further aspects of the invention there are provided a method, a surface, a structure comprising a surface, an apparatus, a component, a particle accelerator, an injection kicker system, a beam kicker magnet, a beamline, a waveguide, a detector, a spacecraft, or a vacuum chamber as described and/or illustrated herein.

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Any feature in any one or more of the aspects of the invention may be applied to any other one or more of the aspects of the invention in any appropriate combination.

#### **BRIEF DESCRIPTION OF THE DRAWINGS**

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Embodiments of the invention are further described hereinafter with reference to the accompanying drawings, in which:

Figure 1 is a schematic diagram of a system used for laser treatment of a surface to reduce photoelectron emission (PEE) and/or secondary electron emission (SEE) effects, for 15 example to reduce photoelectron yield (PEY) and/or secondary photoelectron yield (SEY);

Figure 2 is a plot of SEY as a function of primary electron energy for a sample according to an embodiment;

Figure 3 is a plot of SEY as a function of primary electron energy for the reverse side of the sample of Figure 2;

20 Figures 4 to 9 are plot of SEY as a function of primary electron energy for samples according to further embodiments;

Figures 10a to 10c are scanning electron microscope (SEM) images of surfaces of samples according to embodiments;

25 Figures 11a to 11j are SEM images of surfaces of samples according to further embodiments;

Figure 12 is a graph showing total reflectance, total transmittance and absorptance for samples;

Figure 13 is a plot of SEY as a function of primary electron energy for a sample according to a further embodiment;

30 Figure 14 is a plot of SEY as a function of primary electron energy for the sample of Figure 13, including data after conditioning and exposure to air of the sample;

Figures 15a and 15b are SEM images of surfaces of samples according to embodiments;

35 Figures 16a to 16n are SEM images of surfaces of samples according to further embodiments;

Figures 17a and 17b are schematic illustrations of photo-thermal interaction (PTI) and photo-ablation interaction (PAI) mechanisms;

Figure 18 is a plot of measurements SEY as a function of primary energy for alumina ceramic samples, both before and after coating with a layer of gold; and

5 Figures 19 and 20 are SEM images of the surfaces of the samples that are the subject of Figure 18.

## DETAILED DESCRIPTION

10 Figure 1 shows a system used for laser treatment of a surface to reduce photoelectron emission (PEE) and/or secondary electron emission (SEE) effects, for example to reduce photoelectron yield (PEY) and/or secondary electron yield (SEY).

15 The system 2 of Figure 1 comprises a laser 4 connected to a laser controller 6 which is used to control operation of the laser 4 to emit a pulsed laser radiation beam of desired characteristics. The laser 4 is aligned with a target 8 such that operation of the laser 4 under control of the laser controller 6 forms periodic structures on the surface of the target.

20 In embodiments, the laser may be one of a pulsed Nd:YVO<sub>4</sub> or Nd:YAG or Yb:KYW or Yb:KGW solid-state bulk laser, or a pulsed fibre laser, optionally a Yb, Tm or Nd – doped pulsed solid-state fibre laser. Any other suitable laser may be used in alternative embodiments. In the embodiment of Figure 1, the wavelength of the pulsed laser radiation is 532 nm, but any other suitable wavelength can be used in other embodiments, for example 1064 nm or 355 nm.

25 The controller may comprise a dedicated controller, or a suitably programmed computer. The controller may be implemented in software, hardware or any suitable combination of hardware and software. In some embodiments, the controller may comprise more ASICs (application specific integrated circuits) or FPGAs (field programmable gate arrays) or other 30 suitable circuitry.

35 In the embodiment of Figure 1, the target 8 and laser 4 are located in air and the laser treatment of the surface is performed in air. The target 8 and laser 4 may be positioned in a sealable and/or pumpable chamber 10 that has an associated pump and/or gas supply, and the laser processing of the surface may be performed in vacuum or in desired gaseous

conditions, for example in the presence of a selected reactive gas or inert gas. The chamber 10 is omitted in some embodiments.

In the embodiment of Figure 1, the target is a ceramic target comprising alumina, for example 99.5% or greater than 99.5% pure alumina. Other ceramic targets may be used in other embodiments. For instance, the target may comprise any suitable magnetic, conductive or dielectric ceramic material.

For instance, the target may comprise a ceramic material having a spinel structure, for instance a spinel structure having the formula  $M(Fe_2O_4)$  where  $M$  is a covalent cation.  $M$  may be a covalent cation selected from the group manganese ( $Mn^{2+}$ ), nickel ( $Ni^{2+}$ ), cobalt ( $Co^{2+}$ ), zinc ( $Zn^{2+}$ ), copper ( $Cu^{2+}$ ), magnesium ( $Mg^{2+}$ ). Alternatively  $M$  may represent a monovalent cation, for example lithium ( $Li^+$ ) or even a vacancy or vacancies, for instance in the case where such absences of positive charge may be compensated for by additional trivalent iron cations ( $Fe^{3+}$ ).

Alternatively, in some embodiments the ceramic target may comprise a ferrite material, for example a hexagonal ferrite material, for instance a material having a structure  $M(Fe_{12}O_{19})$ .  $M$  may be selected from the group barium (Ba), strontium (Sr), lead (Pb).

In other embodiments, the ceramic target may comprise a garnet ferrite material, for instance having the structure of the silicate mineral garnet, and for example having the chemical formula  $M_3(Fe_5O_{12})$  where  $M$  may be yttrium or a rare earth ion.

In some embodiments, the ceramic target may comprise a thick- or thin-film resistor or electrode or a material that may be suitable for use as or as part of such thick- or thin-film resistor or electrode. In embodiments, the ceramic target may comprise a metal oxide material, for instance a material selected from the group, lead oxide ( $PbO$ ), ruthenium dioxide ( $RuO_2$ ), bismuth ruthenate ( $Bi_2Ru_2O_7$ ). The ceramic target may comprise a ceramic material having overlapping energy bands.

In other embodiments, the target may comprise a ceramic conductor. For instance, the target may comprise indium oxide ( $Ind_2O_3$ ) and/or tin oxide ( $SnO_2$ ) or indium tin oxide (ITO).

In embodiments, the ceramic target may comprise a heating element or a material that may be suitable for use as or as part of such a heating element. In embodiments, the target may comprise material selected from the group silicon carbide (SiC), molybdenum disilicide (MoSi<sub>2</sub>), lanthanum chromite (LaCr<sub>2</sub>O<sub>4</sub>), zirconia (ZrO<sub>2</sub>).

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In embodiments, the ceramic target may comprise a thermistor or a material that may be suitable for use as or as part of such a thermistor. In embodiments, the target may comprise material selected from the group consisting of iron spinel material, cobalt spinel material and manganese spinel material.

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In embodiments, the ceramic target may comprise a superconductor material, for example yttrium barium copper oxide (YBa<sub>2</sub>Cu<sub>3</sub>O<sub>7</sub>), a bismuth-strontium-calcium-copper oxide material (for example Bi<sub>2</sub>Sr<sub>2</sub>CuO<sub>6</sub>, Bi<sub>2</sub>Sr<sub>2</sub>CaCu<sub>2</sub>O<sub>8</sub>, or Bi<sub>2</sub>Sr<sub>2</sub>Ca<sub>2</sub>Cu<sub>3</sub>O<sub>10</sub>), a thallium-barium-calcium-copper oxide material (for example Tl<sub>2</sub>Ba<sub>2</sub>CuO<sub>6</sub>, Tl<sub>2</sub>Ba<sub>2</sub>CaCu<sub>2</sub>O<sub>8</sub>, Tl<sub>2</sub>Ba<sub>2</sub>Ca<sub>2</sub>Cu<sub>3</sub>O<sub>10</sub>, or TlBa<sub>2</sub>Ca<sub>3</sub>Cu<sub>4</sub>O<sub>11</sub>) or a mercury-barium-calcium-copper oxide material (for example HgBa<sub>2</sub>CuO<sub>4</sub>, HgBa<sub>2</sub>CaCu<sub>2</sub>O<sub>6</sub>, or HgBa<sub>2</sub>Ca<sub>2</sub>Cu<sub>3</sub>O<sub>8</sub>).

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In embodiments, the target may comprise a perovskite material. In embodiments the target may comprise barium titanate (BaTiO<sub>3</sub>) or barium titanate including non-stoichiometric lead, strontium or calcium substitutions.

20

In operation pulsed laser radiation of desired characteristics is scanned across the surface of the target 8 by the laser 4 under control of the laser controller 6 to produce a periodic arrangement of structures on the surface. For example, in order to form peaks and troughs arranged in parallel rows, the laser beam may be scanned along parallel, spaced-apart paths across the surface to form parallel troughs separated by peaks. Any other suitable arrangements of structures can be formed by suitable scanning of the laser beam over the surface.

25

Operating parameters of the laser, and certain equations linking such parameters, can be represented as follows,

Wavelength ( $\lambda$ ) [m]

Repetition rate of the laser ( $\gamma$ ) [Hz]

Pulse length of the laser ( $\tau$ ) [s]

Average power of the laser ( $P_{avg}$ ) [W] – represents the energy flow over one period  $t$

Energy per pulse ( $E_p$ ) [J]

Fluence of the laser ( $F$ ) [J/cm<sup>2</sup>]

5 Beam spot radius on the target ( $r$ ) [m]

Beam spot area on the target ( $A = \pi r^2$ ) [m<sup>2</sup>]

Number of times surface of the target was scanned by the laser beam ( $N$ ) dimensionless

Speed at which surface of the target was scanned by the laser beam ( $V$ ) [m/s]

Number of pulses fired per each spot on the surface of the target ( $n$ ) [dimensionless]

10 Time interval between the pulses – one period ( $t$ ) [s]

Peak Power ( $P_{peak}$ ) [W] – defines the energy flow within a single pulse

Power density or Intensity ( $I$ ) [W/cm<sup>2</sup>]

#### Key equations

$$t = \frac{1}{\gamma}$$

$$n = \frac{(2r)\gamma}{V}$$

$$E_p = \frac{P_{avg}}{\gamma}$$

$$F = \frac{E_{pulse}}{A}$$

$$P_{peak} = \frac{E_{pulse}}{\tau}$$

$$I = \frac{P_{peak}}{A}$$

Suitable operating parameters can be selected, for example based on the equations and representations above, to obtain pulsed laser radiation of desired properties, for example a desired power density of the pulses.

5 Table 1 provides operating parameters of the laser of the apparatus of Figure 1 to produce a desired periodic arrangement of structures on the surface of various samples of alumina. The laser processing of the surface was performed in an argon atmosphere for the PSCA sample and in air for all of the other samples of Table 1.

10

Sample name	PSCA	PS2L1R	PS2C1R	PS2L2R	PS2C2R	PS4L1R	PS1C1R
Wavelength (nm)	532	532	532	532	532	532	532
$\tau$	10 ps	10 ps	10 ps	10 ps	10 ps	10 ps	10 ps
Repetition rate (kHz)	200	200	200	200	200	200	200
Power (W)	2	2	2	2	2	4	1
Laser focal spot diameter ( $\mu\text{m}$ )	12	12	12	12	12	12	12
Pulse energy ( $\mu\text{J}$ )	10.00	10.00	10.00	10.00	10.00	20.00	5.00
Fluence ( $\text{J}/\text{cm}^2$ )	8.84	8.84	8.84	8.84	8.84	17.68	4.42
Structure (cross/line)	Cross	lines	cross	lines	cross	lines	cross
Hatch distance ( $\mu\text{m}$ )	24	24	24	24	24	24	24
Scan speed (mm/s)	6	6	6	6	6	6	6
Passes	1	1	1	2	2	1	1
Pulses per spot per pass	400	400	400	400	400	400	400
Width of laser-processed area	14	15.2	15.2	15.2	15.2	15.2	15.2

(mm)							
Length of laser-processed area (mm)	14	15.2	15.2	15.2	15.2	15.2	15.2
Process time (minutes)	45.37	26.74	53.48	53.48	106.96	26.74	53.48

Table 1

The samples of Table 1 had a thickness of 3 mm, and the laser processed areas of the samples were 14 mm by 14 mm (for sample PSCA) or 15.2 mm by 15.2 mm (for the other samples). Each of the samples were aluminium oxide (alumina) of greater than 99.7% purity, which is the grade used for certain particle accelerator applications.

The secondary electron yield (SEY) of each of the samples of Table 1 was measured for different primary electron energies at either three or four different spots on the samples. To avoid charging effects the surfaces were bombarded with low energy electrons (36eV) between each measurement point. The maximum applied dose to measure one data point was about  $1 \times 10^{-12}$  C. The total dose to measure one spectrum was therefore about  $1 \times 10^{-11}$  C.

Figure 2 is a plot of SEY as a function of primary electron energy for sample PSCA at three different spots on the laser treated surface. Figure 3 is a plot of SEY as a function of primary electron energy for sample PSCA at three different spots on the reverse side of the sample which was not laser treated, for comparison purposes.

It can be seen that the laser treatment of the surface of the PSCA sample resulted in a reduction of SEY from around 8 to 9 (for the untreated reverse surface) to around 2.2 for the laser treated surface.

Figures 4 to 9 are plot of SEY as a function of primary electron energy for samples PS1C1R, PS2C1R, PS2C2R, PS2L1R, PS2L2R and PS4L1R respectively.

The approximate maximum SEY values for the various samples of Table 1 are summarised in Table 2 below.

Sample	Maximum SEY value obtained for laser-treated surface
PSCA	2.2
PS1C1R	2.2
PS2C1R	1.6
PS2C2R	1.7 (outlier 1.9)
PS2L1R	1.9
PS2L2R	2.2
PS4L1R	2.5

Table 2

Scanning electron microscope (SEM) images of the samples of Table 1 were obtained, and show structures formed by the laser treatment of the surfaces of the samples.

5 Figure 10a is an SEM image of the laser treated surface of sample PSCA.

10b shows SEM images of the laser treated surfaces of the PS2L1R sample (top left image), the PS2L2R sample (bottom left image), the PS2C1R sample (top right image) and the PS2C2R sample (bottom right image).

10

Figure 10c shows SEM images of the laser treated surfaces of the PS4L1R sample (left hand image) and the PS1C1R sample (right hand image).

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Figures 11a to 11e are SEM images of laser treated surfaces for which the power density of the laser beam was 0.74 TW/cm<sup>2</sup>, 0.88 TW/cm<sup>2</sup>, 0.95 TW/cm<sup>2</sup>, 2 TW/cm<sup>2</sup>, 1.3 TW/cm<sup>2</sup> respectively and the sample was laser treated in an argon atmosphere. Figures 11f to 11j are SEM images of laser treated surfaces for which the power density of the laser beam was 0.3 TW/cm<sup>2</sup>, 0.4 TW/cm<sup>2</sup>, 2 TW/cm<sup>2</sup>, 0.6 TW/cm<sup>2</sup> and 1 TW/cm<sup>2</sup> respectively and the sample was laser treated in air. Other operating parameters were substantially the same as 20 for sample PSCA of Table 1.

20

It is noted that in a normal, unmagnified view of sample PSCA (which was processed under argon atmosphere) the surface appeared black, whilst in normal unmagnified views of the other samples of Table 1 the surfaces of the samples appeared white, or at least much 25 lighter than the surface of sample PSCA.

Measurements of the spectral properties of samples of aluminium oxide were also performed. Figure 12 is a graph showing total reflectance, total transmittance and absorptance of a sample of aluminium oxide (referred to as C Cera, having a purity of 5 around 99.7%) used by CERN in a kicker magnet and of another sample of aluminium oxide (referred to as White Cera) before any laser processing. The spectra show some absorptance at 532 nm and very low absorptance at 1064 nm. Reflectance is different for the samples, which is in accordance with the different colours of the samples that are apparent to the human eye. The thickness of both samples was 3 mm. It was determined 10 from these measurements that laser processing at 532 nm, or 515 nm - another available laser wavelength, may be suitable.

It can be seen from the results outlined above that the maximum SEY value measured for the laser treated surfaces of the samples of Table 1 varies between 1.6 and 2.2. The 15 sample with the lowest SEY is PS2C1R with a maximum value of 1.6. There seems to be substantially no link between reflectivity and the SEY of the samples. Some samples have outliers at 200eV electron energy, which could be due to inhomogeneities at the surface.

In some other embodiments where the sample is alumina, operating parameters may be 20 selected from Table 3 as follows to produce a desired periodic arrangement of structures on the surface of the sample. The values of the operating parameters may also be selected from Table 3 in the case of other ceramic materials of interest.

Wavelength (nm)	Pulse width range	Focal spot diameter	Repetition rate (KHz)	Average power (W)	Scan speed (mm/s)	Repetition number	Hatch distance (mcm)	Power density (intensity)
355 nm, 532 nm or 1064 nm	500fs – 1ns	1µm - 100µm	10kHz – 200 kHz	1-10	1-100	1-10	10-100	0.1TW/cm <sup>2</sup> to 3TW/cm <sup>2</sup>

Table 3

Good results may be achieved with a power density range of 0.1TW/cm<sup>2</sup> to 3TW/cm<sup>2</sup>, with particularly good results for wavelength of 532 nm in the power density range 0.5 TW/cm<sup>2</sup> to 1.5 TW/cm<sup>2</sup> for processing in argon. However, highly organised structuring is achieved for laser processing in either air or argon.

The results discussed above in relation to Tables 1 to 3 and Figures 2 to 12 were obtained using laser beam power densities in the TW/cm<sup>2</sup> range. In alternative embodiments, laser patterning of ceramic surfaces is obtained using laser beam power densities in the GW/cm<sup>2</sup> range.

Table 4 provides operating parameters of the laser of the apparatus of Figure 1 to produce a desired periodic arrangement of structures on the surface of a sample (referred to as the NSCA sample) of alumina, using laser beam power densities in the GW/cm<sup>2</sup> range. The laser processing of the surface was performed in an argon atmosphere for the NSCA sample.

Sample name	NSCA
Wavelength (nm)	532
τ	10 ns
Repetition rate (kHz)	20
Power (W)	3.46
Laser focal spot diameter (μm)	60
Pulse energy (μJ)	173.0
Fluence (J/cm <sup>2</sup> )	6.12
Structure (cross/line)	cross
Hatch distance (μm)	70
Scan speed (mm/s)	20
Passes	10
Pulses per spot per pass	60
Width of laser-processed area (mm)	14
Length of laser-processed area (mm)	14
Process time (minutes)	46.67

Table 4

Table 4 is in the same format as Table 1 above, which provided operating parameters for certain samples treated with laser power densities in the TW/cm<sup>2</sup> range.

The NSCA sample of Table 1 had a thickness of 3 mm, and the laser processed area of the samples was 14 mm by 14 mm. The sample was aluminium oxide (alumina) of greater than 99.7% purity, which is the grade used for certain particle accelerator applications.

The secondary electron yield (SEY) of the NSCA sample of Table 4 was measured for different primary electron energies at three different spots on the sample. To avoid charging effects the surfaces were bombarded with low energy electrons (36eV) between each measurement point. The maximum applied dose to measure one data point was about 1 x 10<sup>-12</sup> C. The total dose to measure one spectrum was therefore about 1 x 10<sup>-11</sup> C.

Figure 13 is a plot of SEY as a function of primary electron energy for sample NSCA at three different spots on the laser treated surface.

After the performance of the SEY measurements, the NSCA sample was conditioned in an attempt to obtain even lower SEY values by bombarding the sample with 500eV electrons up to a total dose of 1 x 10<sup>-2</sup> C/mm<sup>2</sup> and then exposing the sample to air during one night.

Figure 14 is a plot of SEY as a function of primary electron energy for sample NSCA at three different spots on the laser treated surface following the conditioning using 500eV electrons and exposure to air. The SEY results of Figure 13 are also included on Figure 14 for comparison.

It was found that the SEY results of Figure 14 obtained after the conditioning and air exposure showed an increased maximum SEY, suggesting a reactive surface. The measurements of SEY spectra after the conditioning and air exposure were not well reproducible, for which a possible reason may be implantation of charges into the bulk of the ceramic.

To verify the charging of the NSCA sample surface, X-ray photoelectron spectroscopy measurements to obtain an XPS spectrum were performed following the conditioning and air exposure. The XPS spectrum indicated that aluminium (15 atomic %) and oxygen (79

atomic %) were the main elements present, that carbon contamination was low (1 atomic %) and that some fluorine was present (5 atomic %).

Figures 15a and 15b are SEM images, at different levels of magnification, of the laser

5 treated surface of sample NSCA.

Figures 16a to 16d are SEM images of laser treated surfaces for which the power density of

the laser beam was  $0.25 \text{ GW/cm}^2$ ,  $0.35 \text{ GW/cm}^2$ ,  $0.45 \text{ GW/cm}^2$ , and  $0.55 \text{ GW/cm}^2$

respectively and the sample was laser treated in air. Figures 16e to 16n are SEM images of

10 laser treated surfaces for which the power density of the laser beam was  $0.6 \text{ GW/cm}^2$ ,  $0.65 \text{ GW/cm}^2$ ,

$0.7 \text{ GW/cm}^2$ ,  $0.75 \text{ GW/cm}^2$ ,  $0.8 \text{ GW/cm}^2$ ,  $0.85 \text{ GW/cm}^2$ ,  $0.9 \text{ GW/cm}^2$ ,  $0.95 \text{ GW/cm}^2$ ,

$1 \text{ GW/cm}^2$  and  $1.5 \text{ GW/cm}^2$  respectively and the sample was laser treated in an

argon atmosphere. Other operating parameters were substantially the same as for sample

NSCA of Table 4.

15

In some other embodiments where the sample is alumina, operating parameters may be selected from Table 5 as follows to produce a desired periodic arrangement of structures on the surface of the sample. The values of the operating parameters may also be selected from Table 5 in the case of other ceramic materials of interest.

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Wavelength (nm)	Pulse width range	Focal spot diameter	Repetition rate (KHz)	Average power (W)	Scan speed (mm/s)	Repetition number	Hatch distance (mcm)	Power density (intensity)
355 nm, 532 nm or 1064 nm	1ns – 100ns	20μm - 100μm	10kHz – 200 kHz	3-8	10-50	1-10	10-100	0.002GW/cm <sup>2</sup> to 3GW/cm <sup>2</sup>

Table 5

Good results may be achieved with a power density range of  $0.1 \text{ GW/cm}^2$  to  $3 \text{ GW/cm}^2$ , with

particularly good results for wavelength of 532 nm in the power density range  $0.2 \text{ GW/cm}^2$  to

25  $1 \text{ GW/cm}^2$  for processing in argon. However, highly organised structuring is achieved for

laser processing in either air or argon.

It is a feature of embodiments that periodic structures can be formed on ceramic surfaces by applying to the surfaces laser radiation having a power density in the  $\text{TW/cm}^2$  range or in the

GW/cm<sup>2</sup> range. Without wishing to be bound by theory, and without limitation to the scope of protection, the following comments are provided which relate to processes which may occur in relation to at least some embodiments.

5     Laser engineering provides an overarching methodology that provides for the formation of periodic structures according to embodiments. Precision laser engineering is expected to excite free electrons within metals, vibrations within insulators, and indeed both types of excitations within semiconductors. The mechanisms by which lasers can engineer materials include the following:

10

- (i)     Photo-thermal interaction (PTI) – commonly achieved using laser beams providing short dwell time (e.g. lasers with nanosecond pulsewidth);
- (ii)    Photo-ablation interaction (PAI) – envisaged using laser beams providing ultra-short dwell time (e.g. lasers with picosecond or femtosecond pulsewidth).

15

The laser processing in respect of the embodiments described in relation to Tables 4 and 5 and Figures 13 to 16 may be in the PTI regime. The laser processing in respect of the embodiments described in relation to Tables 1 to 3 and Figures 2 to 11 may be in the PAI regime.

20

In the PTI regime the focused laser beam acts as a spatially confined, intense heat source. Targeted material is heated up rapidly, eventually causing it to be vaporized. Without wishing to imply any limitation to the scope of protection, the targeted material could be referred to as being boiled away. An advantage of this approach is that it may enable rapid 25 removal of relatively large amount of target material. However, the peripheral heat affected zone (HAZ) damage and the presence of some recast material after processing present limitations in terms of heat confinement for precision laser materials engineering.

In the PAI regime, the laser drives multi-photon absorption of light inside the material. This 30 strips electrons from the material, which then explode away due to Coulomb repulsion. Because PAI involves directly breaking the molecular or atomic bonds that hold the material together, rather than simply heating it, it is intrinsically not a 'hot' process. Since the material is removed in a very short timeframe, the ablated material carries away most of the energy before heat can spread into the surrounding material. These effects may result in a 35 significantly reduced HAZ. Furthermore, this is a clean process and may leave minimal

recast material, thereby eliminating the need for elaborate post-processing. The PAI mechanism is compatible with a very broad range of materials, including high band-gap materials that have low linear optical absorption and therefore are difficult to engineer with existing techniques. The PAI mechanism can be considered 'wavelength neutral'; that is, 5 nonlinear absorption can be reduced even if the material is normally transmissive at the laser wavelength.

The PAI mechanism should fundamentally allow for custom design of electron work function of ceramic surfaces. Ceramics usually consist of metallic and non-metallic atoms joined by 10 bonds that are partly ionic and partly covalent, giving them such properties such as hardness, brittleness and resistance to heat. Therefore, it may be of importance to correctly identify parameters that may play a significant role in the light-matter interaction mechanisms in these materials and ultimately contribute to challenges of the laser precision structuring processes and the design of the surface potential of ceramic surfaces.

15 The PTI and PAI mechanism are illustrated schematically in Figures 17a and 17b respectively.

It is a further feature of embodiments that the characteristics of the pulsed radiation that is 20 applied to the surface, for example the use of pulse durations in the picosecond range or less, may be such that the periodic structures that are formed may be of shallower depth and/or more gently sloped than features formed using pulsed radiation of higher energy and/or longer duration for example pulse durations in the nano-second range.

25 Again without wishing to be bound by theory, and without limitation to the scope of protection, the following further comments are provided which relate to processes which may occur in relation to at least some embodiments.

In irradiation at very high intensities (or high irradiance) one is confronted with the issue of a 30 dense, strongly absorbing material, in the first few tens of nm of which energy at a rate of some  $10^{20}$  W/cm<sup>3</sup> is liberated. Part of this energy, once randomised, is conducted into the bulk of the material, while part is converted into directed kinetic energy by thermal expansion of the heated layer. Two regimes are distinguished in this respect.

1. Nanosecond pulsed laser interaction which is dominated by the expansion and ablation of material. Here the thermal pressure of the heated layer is sufficient to cause significant compression of the underlying target material.

5 2. Picosecond pulsed laser interaction (which is heat conduction dominated since hydrodynamic motion during the pulse duration is negligible (laser pulses here may be 1000 times or more shorter than nanosecond ones). In the picosecond regime the strong heating of the dense material may occur before hydrodynamic expansion of the processed layer has even started. The plasmas produced in this regime may have essentially the same density  
10 as the solid target itself. This - upon cooling - leads to the formation of fine structures - in the range from 1 micrometres to 50 micrometres depending on the irradiation parameters - covered with nano-structures.

15 Using picosecond duration pulsed radiation according to some embodiments can in some cases also cause formation of nano-ripples or other small scale structures on the surface in addition to the larger scale peaks and troughs obtained by scanning the laser beam in an appropriate pattern over the surface. It is possible that such nano-ripples or other small scale structures may in some cases decrease the PEY or SEY further, in addition to the reduction obtained by larger periodic peak and trough structures. Furthermore, in some  
20 cases the nano-ripples or other small scale structures and/or the shallower peaks and troughs associate with picosecond rather than nanosecond pulses may also provide improved or alternative electrical properties of the surface, for example reduced induction, and/or can provide the surface with an increased area at the nano- or micro- scale.

25 Again, without wishing to be bound by theory, and without limitation to the scope of protection, further comments are as follows.

30 With increasing surface roughness the maximum SEY may decrease for a surface characterized by (for example statistically containing) more valleys, while it may increase significantly at a surface spread with (for example statistically containing) more hills. The observation indicates that hill and valley structures may be very effective in increasing and decreasing the SEY, respectively, due to their different morphologic features and surface electron work functions (EWF).

The total SEY may denote the ratio of both emitted true secondary electrons (SEs) and backscattered electrons (BSEs) to primary electrons (PEs) incident to the surface.

Example: Sample surfaces exposed to air can be easily contaminated by adsorbed gases

5 and hydrocarbons, and their SEY may increase.

High SEY caused by contaminations should be likely to give rise to the electron multiplication and eventually degrades the performance of microwave devices and the destructive electron-cloud instability in large particle accelerators.

10

Increase in SEY indicates the reduction in electron work function (EWF).

With increasing roughness  $SEY_{max}$  has a significant increase for surfaces that are spared by hills. This phenomenon implies that hill structures should play a positive role in the SE 15 emission. Moreover,  $SEY_{max}$  decreases rapidly by surfaces that are mainly characterized by valleys, which should be the dominant factor of the reduction in  $SEY_{max}$ .

In the case of valley structures, SEs can be trapped effectively through collisions with

20 sidewalls, thus the SEY declines. Nevertheless, for hill structures, apart from the negative effect of sidewalls, there are some positive effects on SE emission. For example, some PEs strike the local surfaces with hills obliquely, which will induce more SEs than normal incidence. Additionally, SEs are likely to re-enter sidewalls of the hills, resulting in further SEs generations. Most re-entered SEs should be the BSEs those with high energies to 25 overcome the surface potential barrier and generate plenty of true SEs with low energies escaping to the vacuum.

Changes in the electron work function (EWF) induced by different surface morphologies may

also be responsible for the SEY variations. The work function may decrease at surface 30 peaks and increases at surface valleys with increasing the surface roughness. Hills and valleys in our structuring work may be considered as surface peaks and valleys. A rougher surface introduced by hill structures often has a lower electron work function (EWF), thus the SEY naturally increases. However, the EWF will be enhanced by roughing a surface with valley structures, and finally the SEY decreases.

35

It has been found that forming of a metal layer on the ceramic surface after the laser treatment that forms the periodic structures can result in a significant reduction of SEY. Figure 18 is a plot of measurements SEY as a function of primary energy for the alumina ceramic samples with sample names PS2C1R and PS2C1R mentioned above, both before 5 and after coating with a layer of gold of 10 nm thickness. It can be seen that there is a significant reduction of SEY for both samples.

Figures 19 and 20 show SEM images of the surfaces of the PS2C1R and PS2C1R alumina sample after coating with the gold layer.

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In alternative embodiments any other suitable metal of any other suitable thickness may be used for the metal layer on the ceramic surface.

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The layer of gold or other metal may be formed using any suitable deposition process, for example any suitable chemical or physical vapour deposition process, for instance a sputtering process, an evaporative deposition process or a laser deposition process. By way of example, an Edwards (RTM) 308 coating unit may be used to form the coating. Any other suitable deposition apparatus may be used.

20

In alternative embodiments, the ceramic surface, or a metal layer deposited on the ceramic surface may be subject to a degreasing, cleaning or smoothing process and/or a surface carbon reduction process after the applying of the laser radiation, which may result in a decrease in SEY. Cleaning using an NGL (RTM) degreasing product may be used. Any suitable degreasing, cleaning, smoothing or surface carbon reduction process may be used

25

in alternative embodiments. The degreaser may, in some embodiments, be such as to not change substantially the morphology of the sample but may remove a layer of carbon or carbon-containing compounds, mixtures or other materials or other undesired and/or extraneous compounds, mixtures or materials from the surface, for example metal oxides, grease or dirt. For example, in some embodiments 99.7 % glacial acetic acid (any other suitable concentration may be used) may be used for example at room temperature to remove surface materials, for example copper (I) and copper (II) oxides and/or other materials without substantially changing the surface morphology.

30

It will be understood that the present invention has been described above purely by way of example, and modifications of detail can be made within the scope of the invention. Each

feature in the description, and (where appropriate) the drawings may be provided independently or in any appropriate combination with any other such feature.

**CLAIMS**

1. A method of reducing photoelectron yield (PEY) and/or secondary electron yield (SEY) of a ceramic surface, comprising applying pulsed laser radiation comprising a series 5 of laser pulses to the surface to produce a periodic arrangement of structures on the surface.
2. A method according to Claim 1, wherein a power density of the pulses is in a range 0.1 TW/cm<sup>2</sup> to 3 TW/cm<sup>2</sup>, optionally in a range 0.5 TW/cm<sup>2</sup> to 1.5 TW/cm<sup>2</sup>.
- 10 3. A method according to Claim 1, wherein a power density of the pulses is in a range 0.1 GW/cm<sup>2</sup> to 3 GW/cm<sup>2</sup>, optionally in a range 0.2 GW/cm<sup>2</sup> to 1 GW/cm<sup>2</sup>.
- 15 4. A method according to any preceding claim, wherein the applying of the laser radiation is such as to alter the properties of the surface such that the surface has a value of SEY less than 2.5, optionally less than 2.0, optionally less than or equal to 1.6, optionally less than or equal to 1.4, optionally in a range 0.2 to 2.0, optionally in a range 0.5 to 1.6, optionally in a range 1.0 to 1.4.
- 20 5. A method according to any preceding claim, wherein the laser pulses have a duration less than a thermal relaxation time of the material of the surface.
- 25 6. A method according to any preceding claim, wherein a pulse duration of the laser pulses may be in a range 300 femtoseconds (fs) to 1 nanosecond (ns), optionally in range 1 ns to 100 ns.
7. The pulse duration may be in a range 1 ps to 100 ps. The pulse duration may be in a range 1 ps to 50 ps. The pulse duration may be in a range 5ps to 500 ps
- 30 8. A method according to any preceding claim, wherein the periodic arrangement of structures on the surface comprises a periodic series of peaks and troughs substantially parallel to each other, and optionally the peaks may be substantially flat on top and/or may be rounded on top and/or may have substantially no pointed and/or sharp regions on top.
- 35 9. A method according to any preceding claim, wherein the peak to trough distance for at least some of the peaks, and/or an average or median peak to trough distance, is in a

range 1  $\mu\text{m}$  to 100  $\mu\text{m}$ , optionally in a range 20  $\mu\text{m}$  to 80  $\mu\text{m}$ , optionally in a range 30  $\mu\text{m}$  to 60  $\mu\text{m}$ .

10. A method according to any preceding claim, wherein the periodic arrangement of  
5 structures comprises a cross-hatched arrangement; or an arrangement of substantially  
parallel lines of peaks and troughs substantially without cross-hatching.

11. A method according to any preceding claim, wherein the periodic arrangement of  
structures is produced by a single pass of a laser source that provides the laser radiation.

10 12. A method according to any preceding claim, wherein the laser radiation comprises a  
pulsed laser beam that has a focal spot diameter on the surface in a range 5  $\mu\text{m}$  to 100  $\mu\text{m}$   
or in a range 1  $\mu\text{m}$  to 100  $\mu\text{m}$ .

15 13. A method according to any preceding claim, wherein the pulsed radiation has a pulse  
repetition rate in a range 10 kHz to 1 MHz.

14. A method according to any preceding claim, wherein an average power of the laser  
radiation may be in a range 3W to 8W or in a range 1W to 10W, or in a range 0.3 W to 2W,  
20 or in a range 1 W to 5 W, or in a range 0.1 W to 1 W, or in a range 0.1 W to 2 W, or in a  
range 0.3W to 5W.

15. A method according to any preceding claim, wherein the applying of the laser  
radiation to the surface comprises scanning a pulsed laser beam over the surface, and a  
25 scan speed for the scanning is in a range 1 mm/s to 200 mm/s.

16. A method according to any preceding claim, wherein the scanning of the pulsed laser  
beam over the surface is repeated between 2 and 10 times, or is performed once.

30 17. A method according to any preceding claim, wherein an angle of incidence of the  
laser radiation to the surface is in a range from 0 to 30 degrees, or from 90 degree to 60  
degrees.

35 18. A method according to any preceding claim, wherein a wavelength of the radiation is  
in a range 100 nm to 2,000 nm, optionally 355 nm or 532 nm or 1064 nm.

19. A method according to any preceding claim, wherein the periodic arrangement of structures comprises a first series of peaks and troughs arranged in a first direction, and a second series of peaks and troughs arranged in a second, different direction.

5

20. A method according to any preceding claim, wherein the first series of peaks and troughs and the second series of peaks and troughs intersect such that the periodic arrangement of structures comprises a cross-hatched arrangement.

10 21. A method according to any preceding claim, wherein the laser radiation is such that the applying of the laser radiation to the surface produces further structures, and the further structures are smaller than the structures of the periodic arrangement of structures.

15 22. A method according to any preceding claim, wherein the further structures comprise further periodic structures, optionally nano-ripples.

23. A method according to any preceding claim, wherein the further structures comprise laser induced periodic surface structures (LIPPS).

20 24. A method according to any preceding claim, wherein the further structures have periodicity in a range 10 nm to 1  $\mu$ m, optionally in a range 100 nm to 1  $\mu$ m.

25 25. A method according to any preceding claim, wherein the further structures cover at least part of the periodic array of structure and/or are formed in the troughs and/or on the peaks of the periodic arrangement of structures.

26. A method according to any preceding claim, wherein the surface forms part of a laminated structure.

30 27. A method according to any preceding claim, wherein the surface forms part of a particle accelerator, an injection kicker system, a beamline, a waveguide for example an r.f. waveguide, a detector, a detector apparatus, a spacecraft, or a vacuum chamber.

35 28. A method according to any preceding claim, wherein the surface comprises a surface of a component of an apparatus, and the method comprises applying the laser radiation to

the surface to produce the periodic arrangement of structures on the surface and then installing the component in the apparatus, or the method comprise applying the laser radiation to the surface with the component in situ in the apparatus.

5 29. A method according to any preceding claim, further comprising forming a metal layer on at least part of the surface after the applying of the laser radiation.

10 30. A method according to any preceding claim, comprising at least one of degreasing, cleaning or smoothing the surface after the applying of the laser radiation and/or performing a surface carbon reduction process with respect to said surface after the applying of the laser radiation.

31. An apparatus for reducing photoelectron yield (PEY) and/or secondary electron yield (SEY) of a ceramic surface, comprising:

15 a laser source for applying pulsed laser radiation to a surface; and  
a laser controller configured to control the laser source to apply the laser radiation as a series of laser pulses so as to produce a periodic arrangement of structures on the ceramic surface.

20 32. A laser treated ceramic surface comprising a periodic arrangement of structures.

33. A laser treated ceramic surface according to Claim 32, further comprising a metal layer covering at least part of the periodic arrangement of structures.

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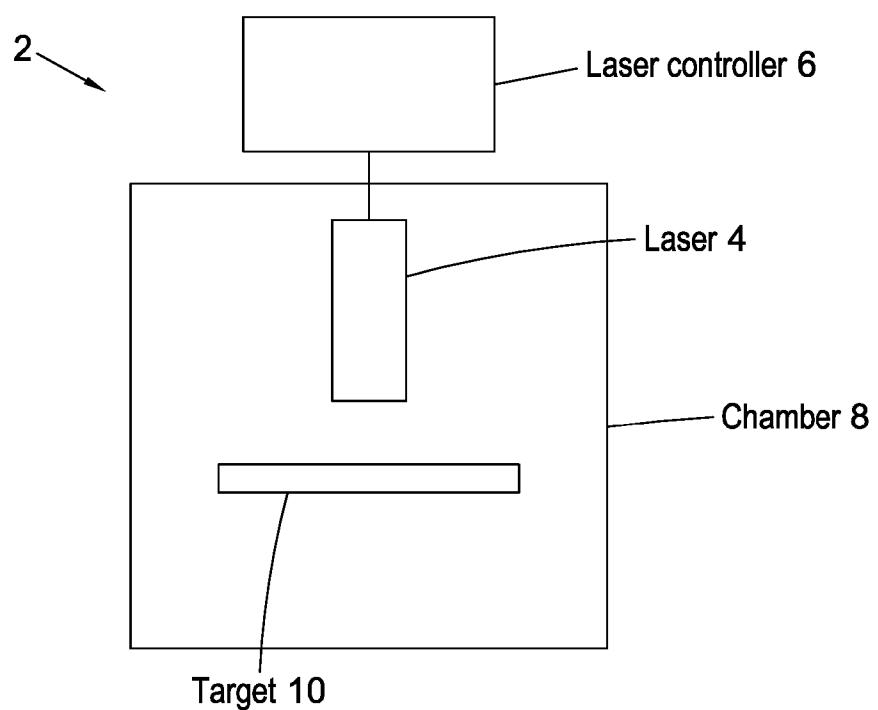


Fig. 1

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SEY spectrum of Laser structured ceramic PSCA, pulsed mode, with neutralisation

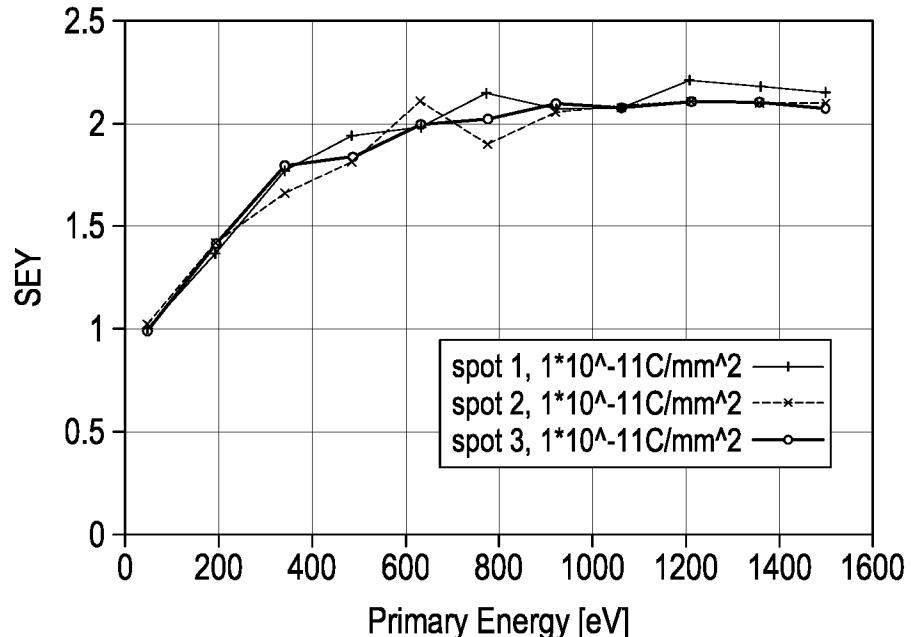


Fig. 2

SEY spectrum of Laser structured ceramic (backside, pulsed mode, with neutralisation)

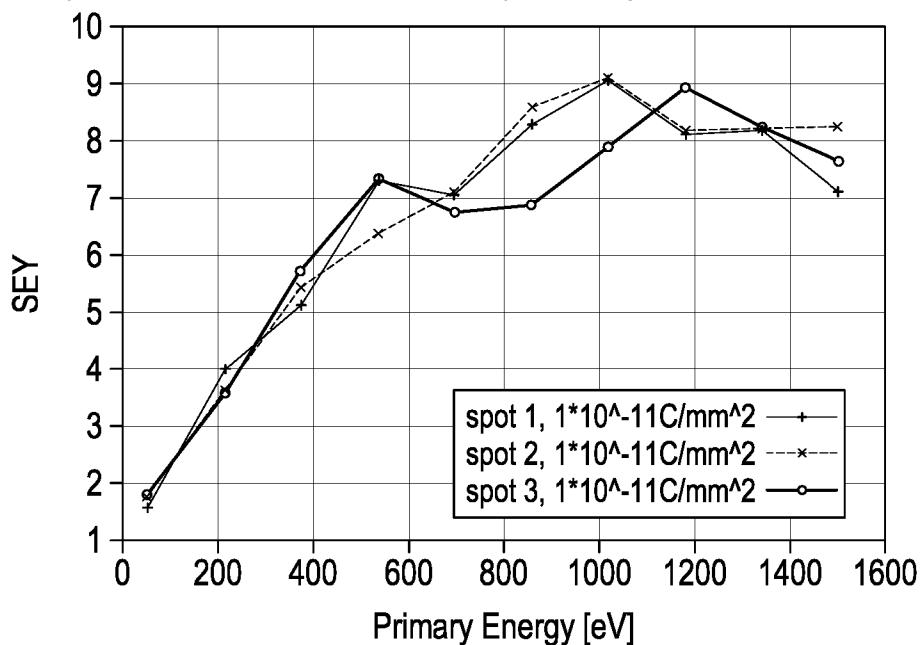


Fig. 3

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SEY spectrum of Laser structured ceramic PS1-C1R, pulsed mode, with neutralisation

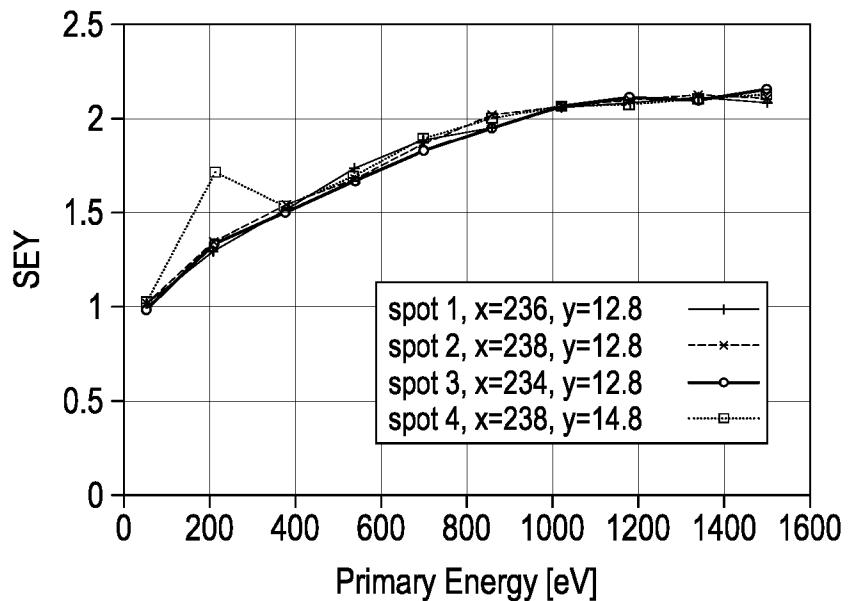


Fig. 4

SEY spectrum of Laser structured ceramic PS2-C1R, pulsed mode, with neutralisation

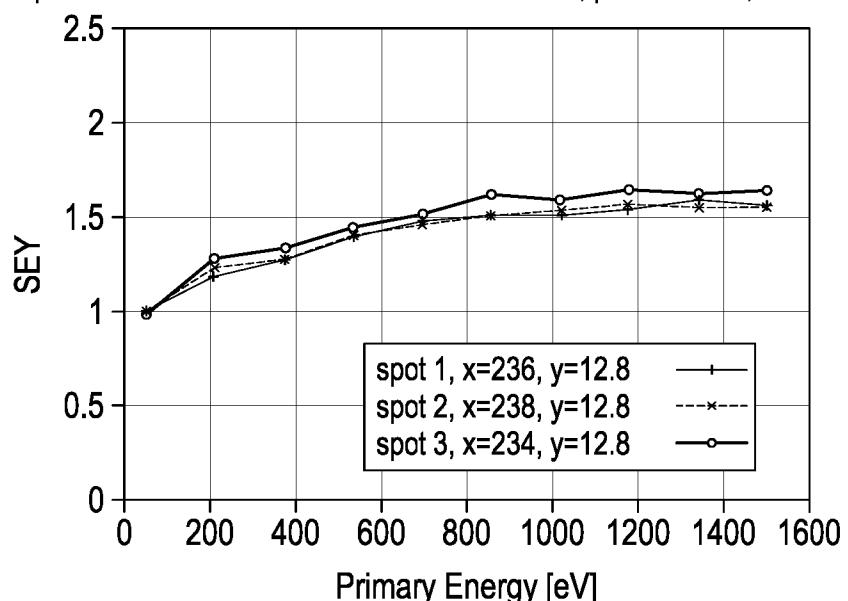


Fig. 5

SEY spectrum of Laser structured ceramic PS2-C2R, pulsed mode, with neutralisation

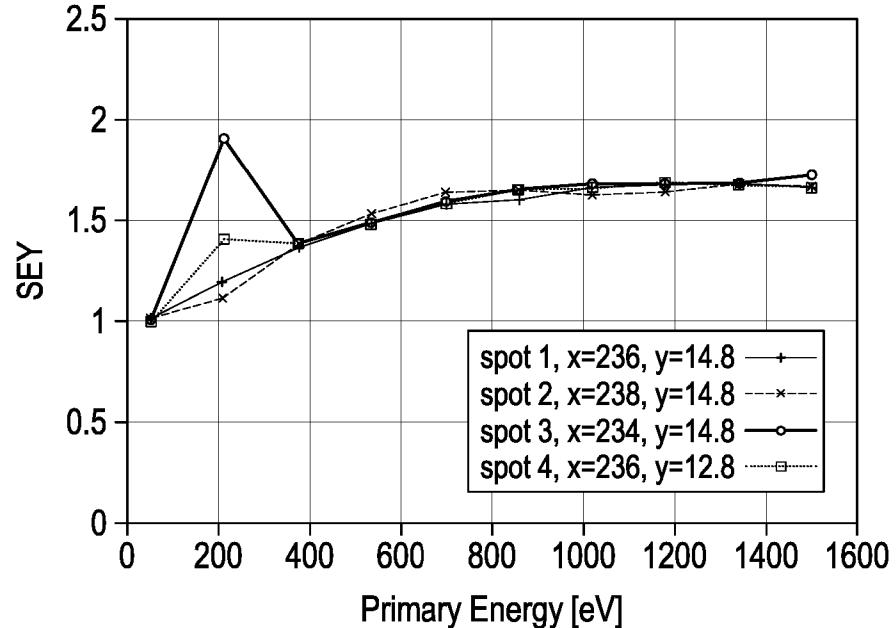


Fig. 6

SEY spectrum of Laser structured ceramic PS2-L1R, pulsed mode, with and w/o neutralisation

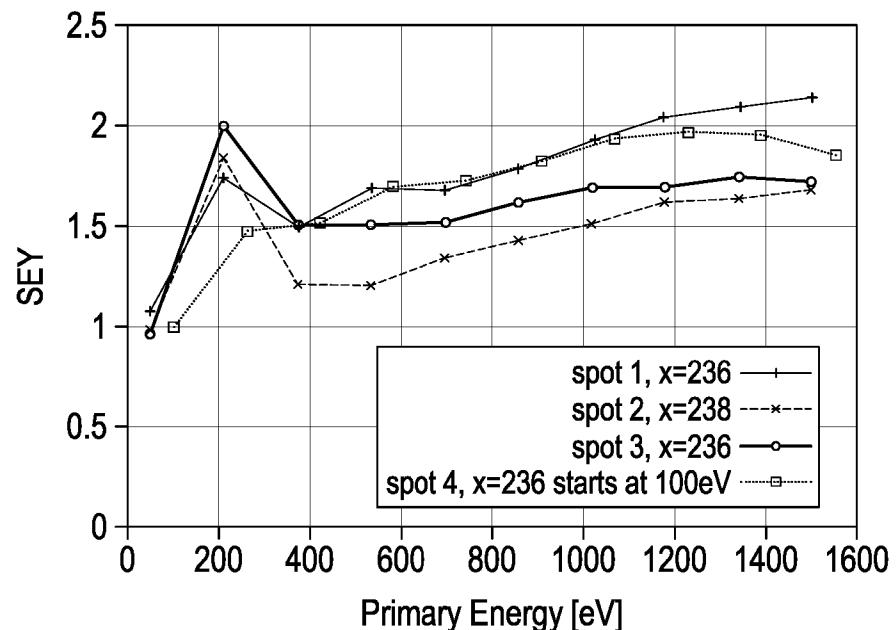


Fig. 7

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SEY spectrum of Laser structured ceramic PS2-L2R, pulsed mode, with and w/o neutralisation

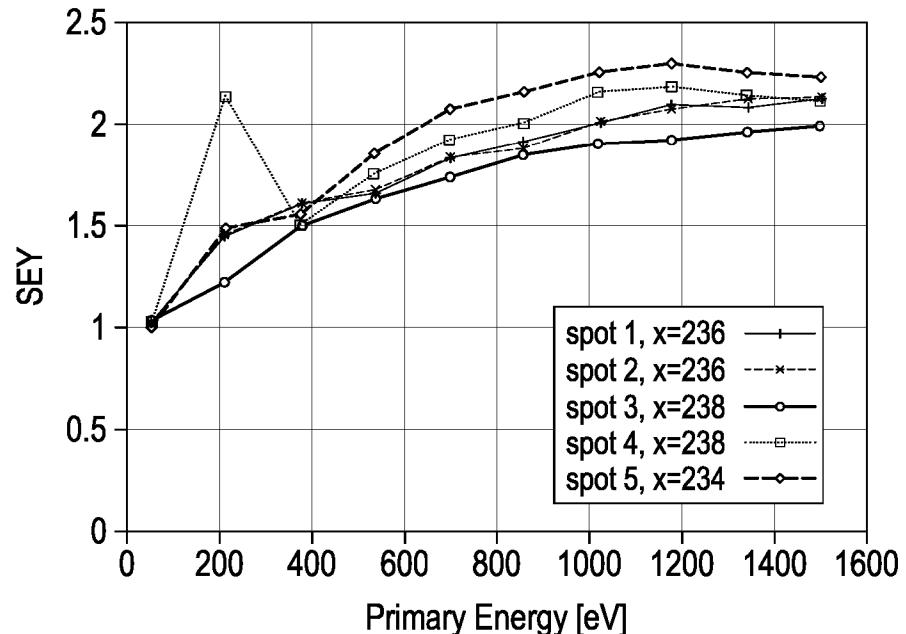


Fig. 8

SEY spectrum of Laser structured ceramic PS4-L1R, pulsed mode, with neutralisation

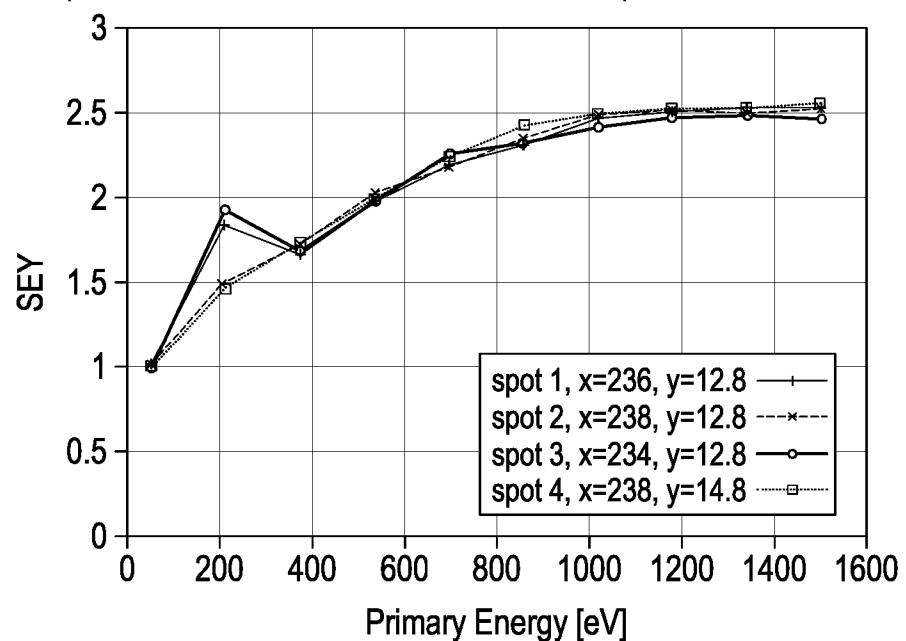


Fig. 9

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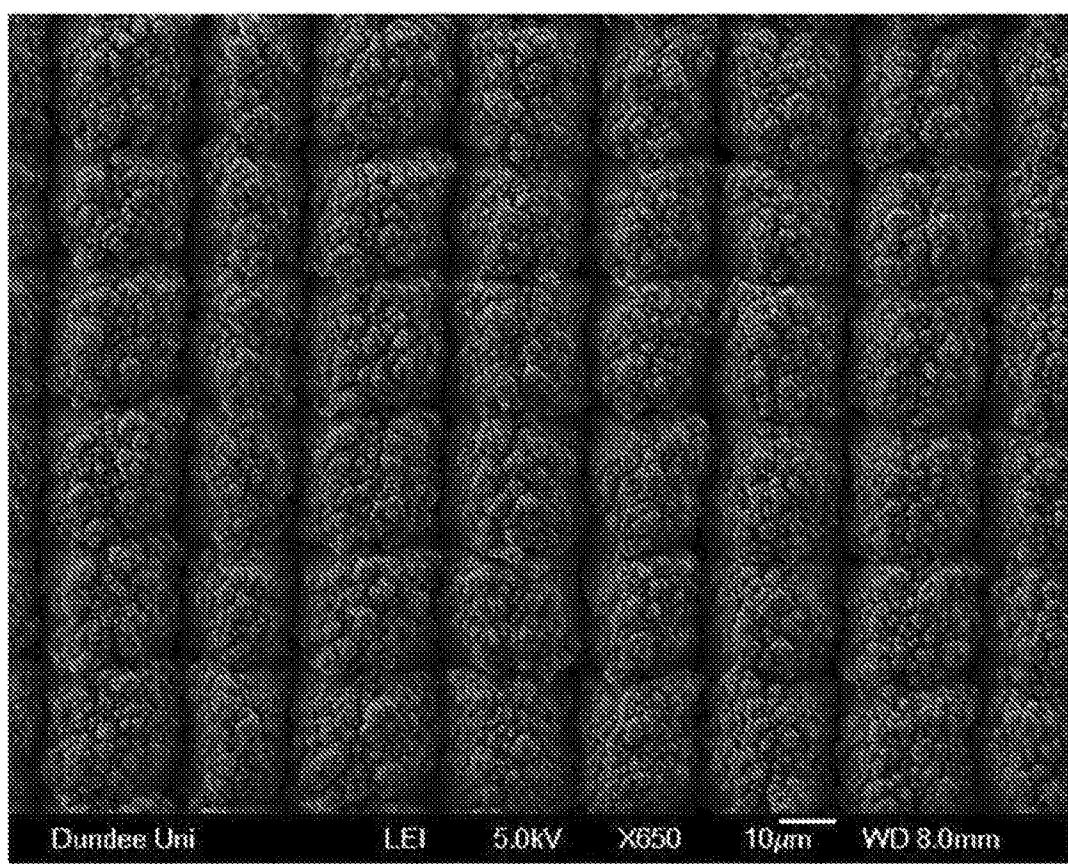


Fig. 10a

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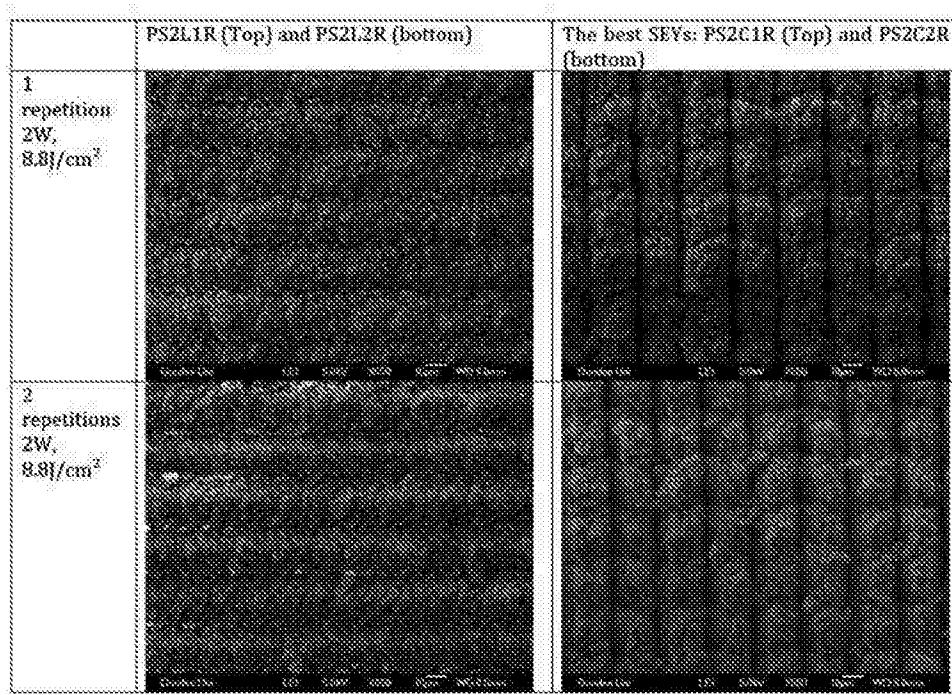


Fig. 10b

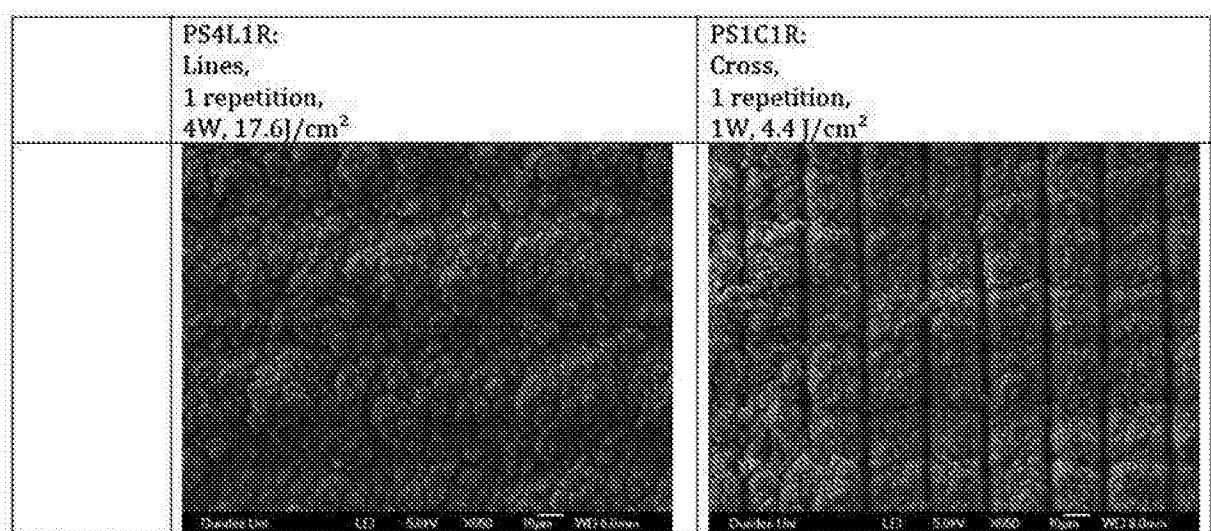


Fig. 10c

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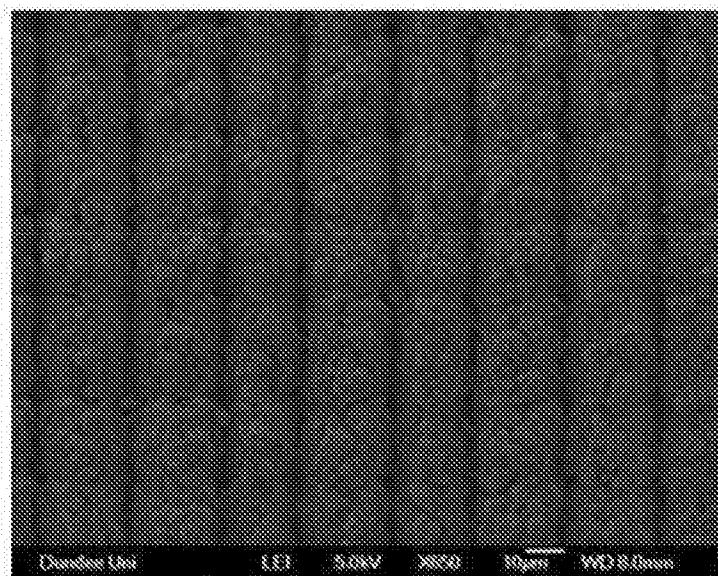
Argon – 0.74 TW/cm<sup>2</sup>

Fig. 11a

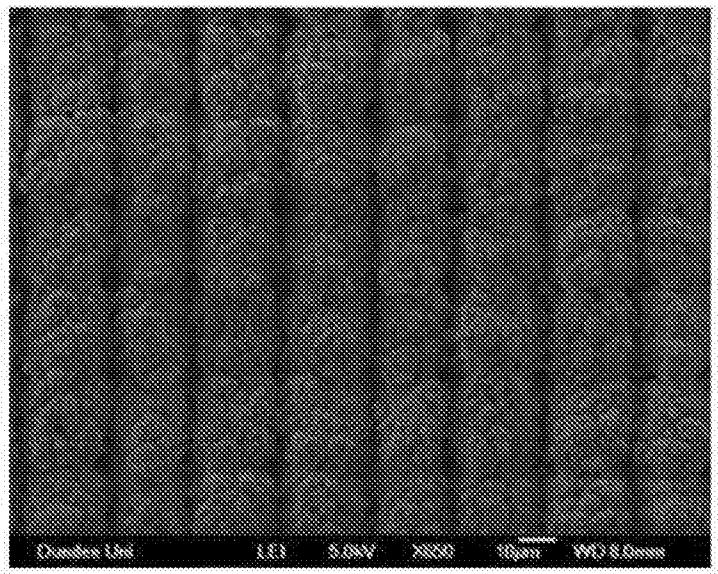
Argon – 0.88 TW/cm<sup>2</sup>

Fig. 11b

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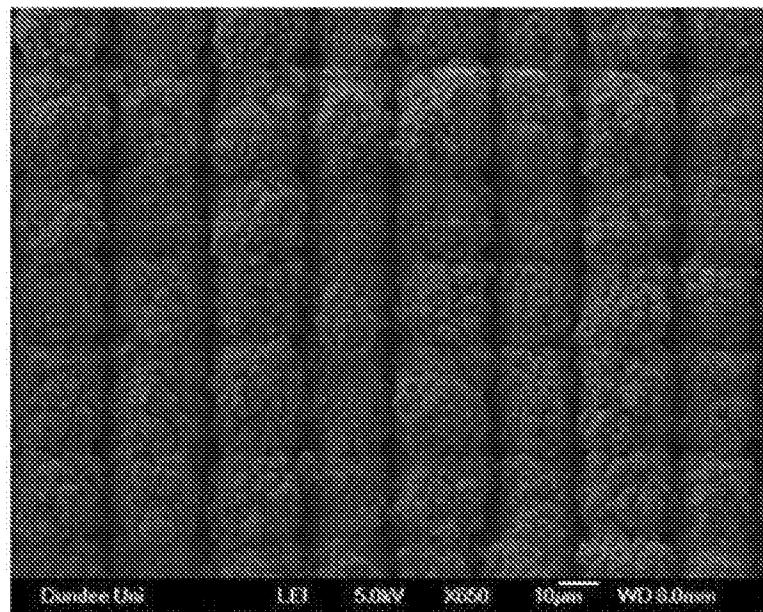
Argon – 0.95 TW/cm<sup>2</sup>

Fig. 11c

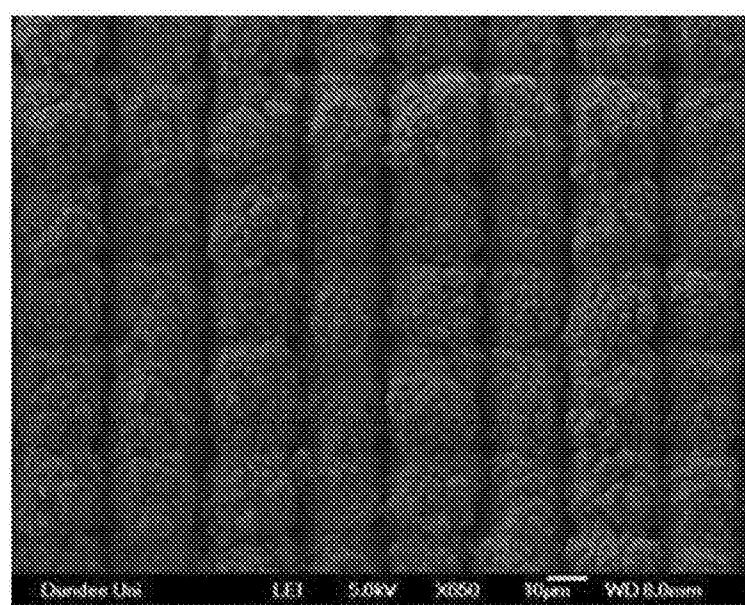
Argon – 2 TW/cm<sup>2</sup>

Fig. 11d

10/24

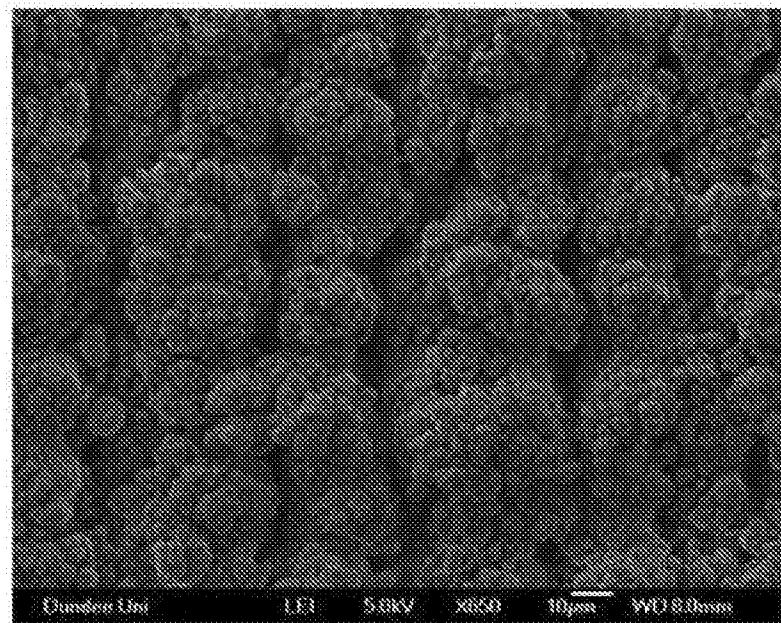
Argon – 1.3 TW/cm<sup>2</sup>

Fig. 11e

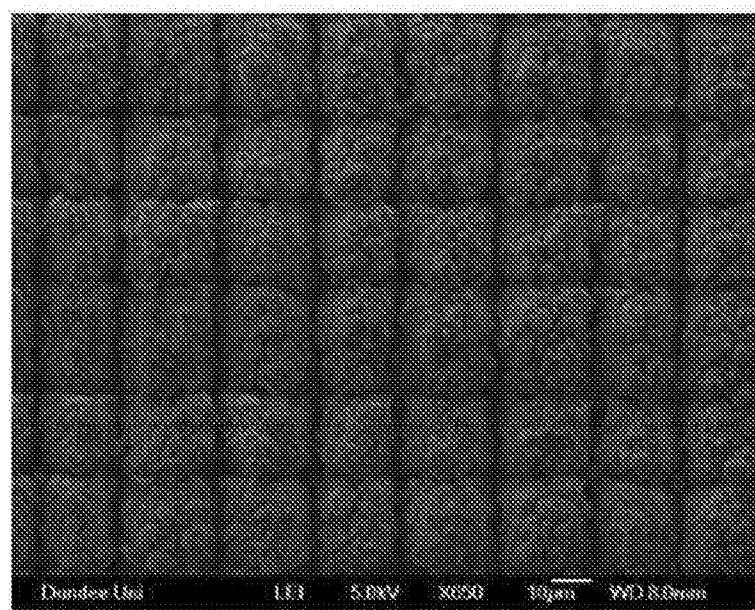
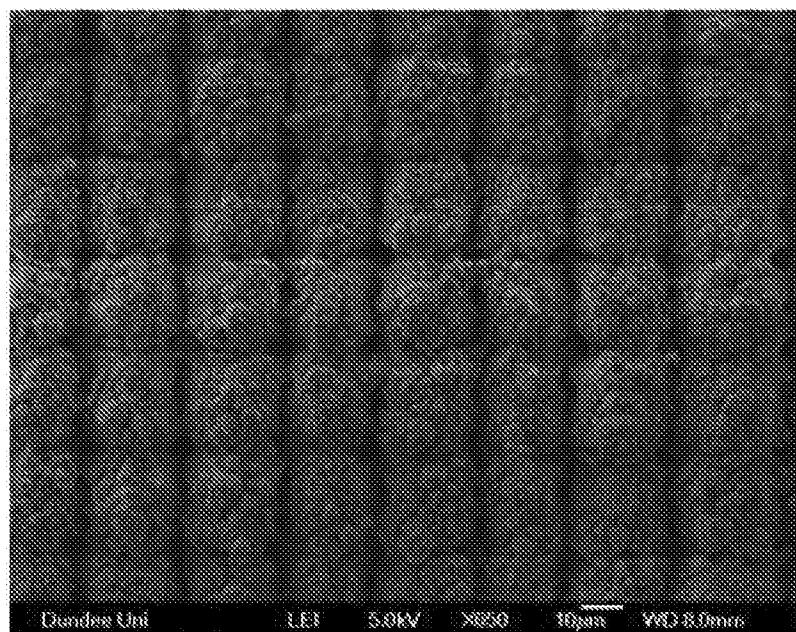
Air – 0.3 TW/cm<sup>2</sup>

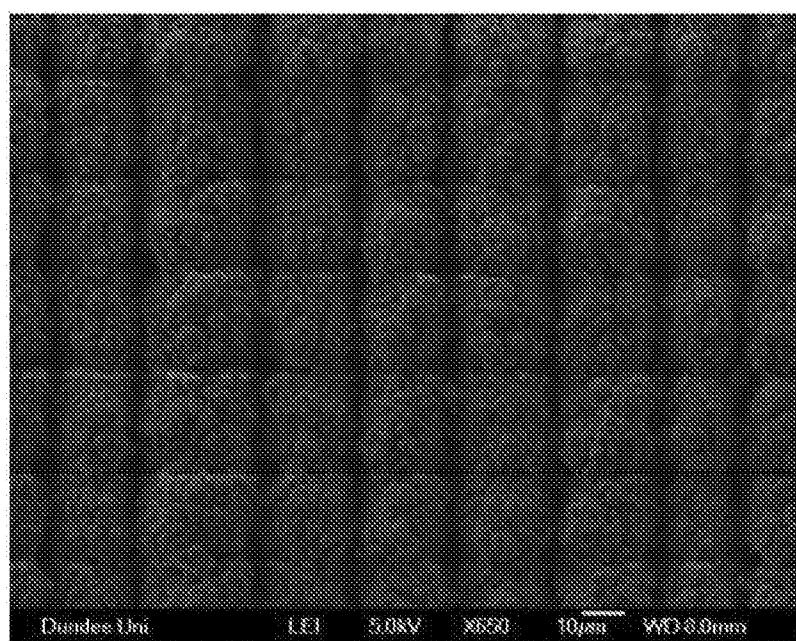
Fig. 11f

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Argon – 0.4 TW/cm<sup>2</sup>

Fig. 11g



Argon – 2 TW/cm<sup>2</sup>

Fig. 11h

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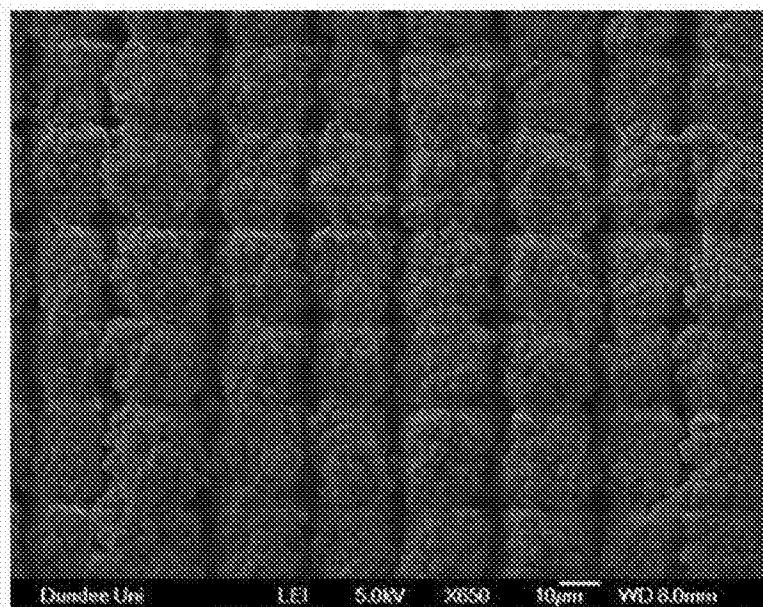
Air – 0.6 TW/cm<sup>2</sup>

Fig. 11i

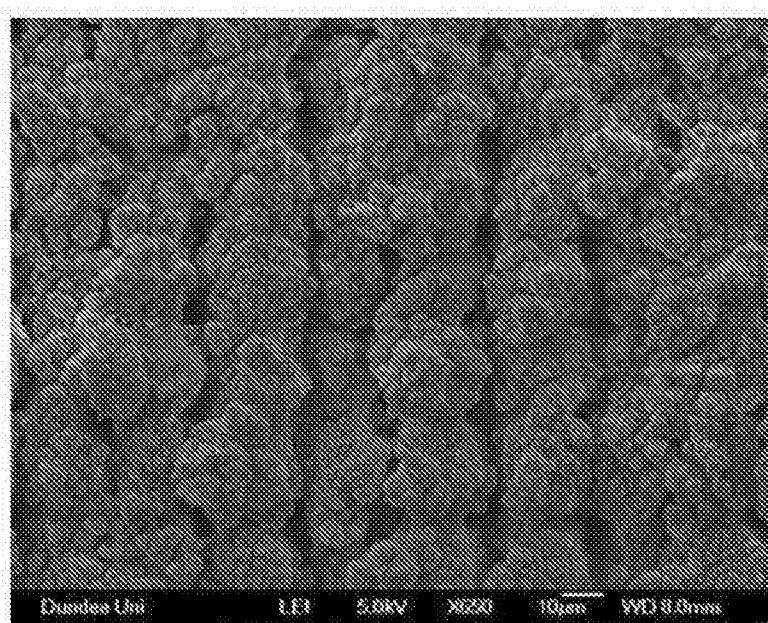
Air – 1 TW/cm<sup>2</sup>

Fig. 11j

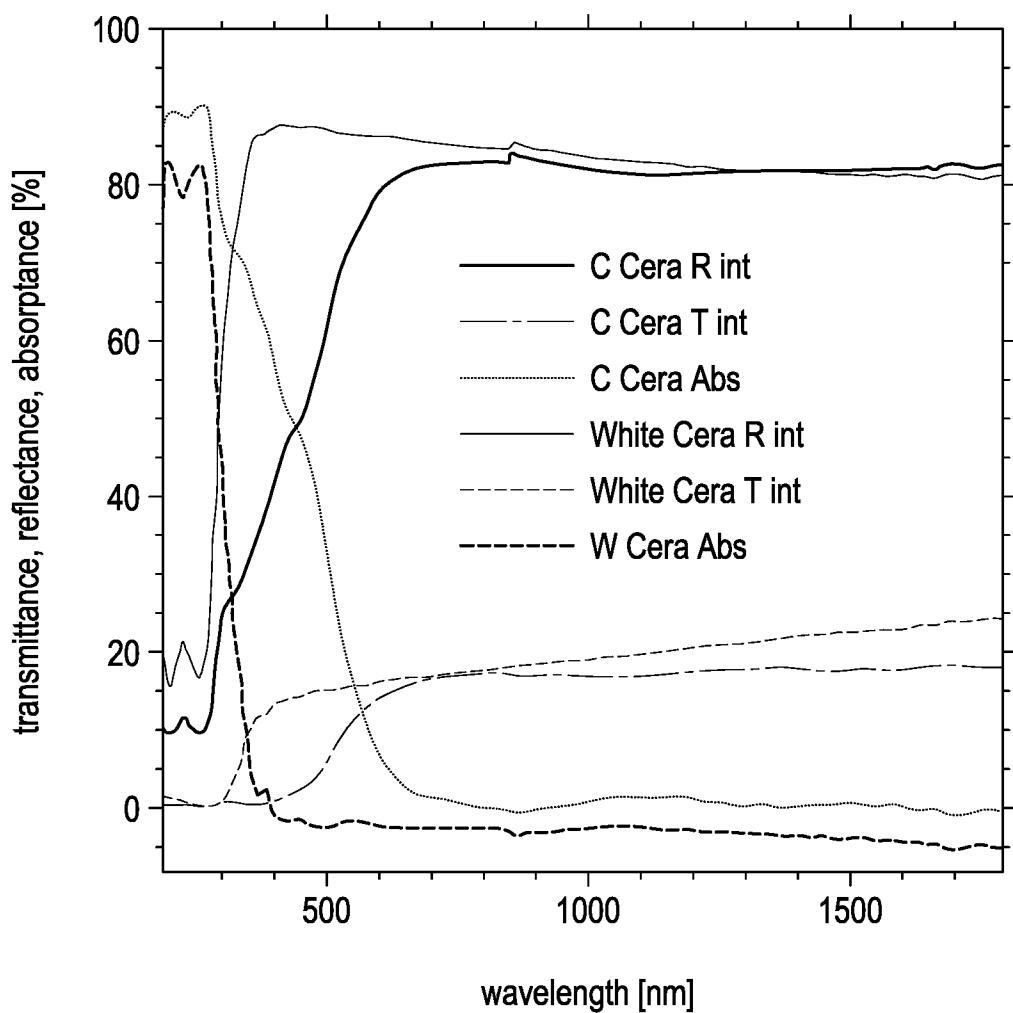


Fig. 12

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SEY spectrum of Laser structured ceramic NSCA, pulsed mode, with neutralisation

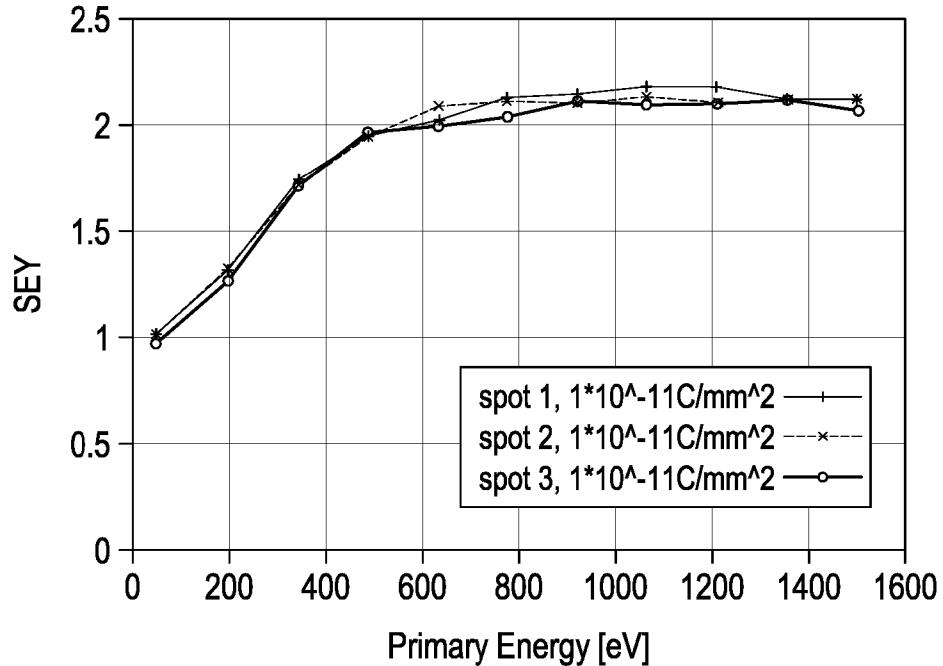


Fig. 13

SEY spectrum of Laser structured ceramic (NCSA, pulsed mode with neutralisation)

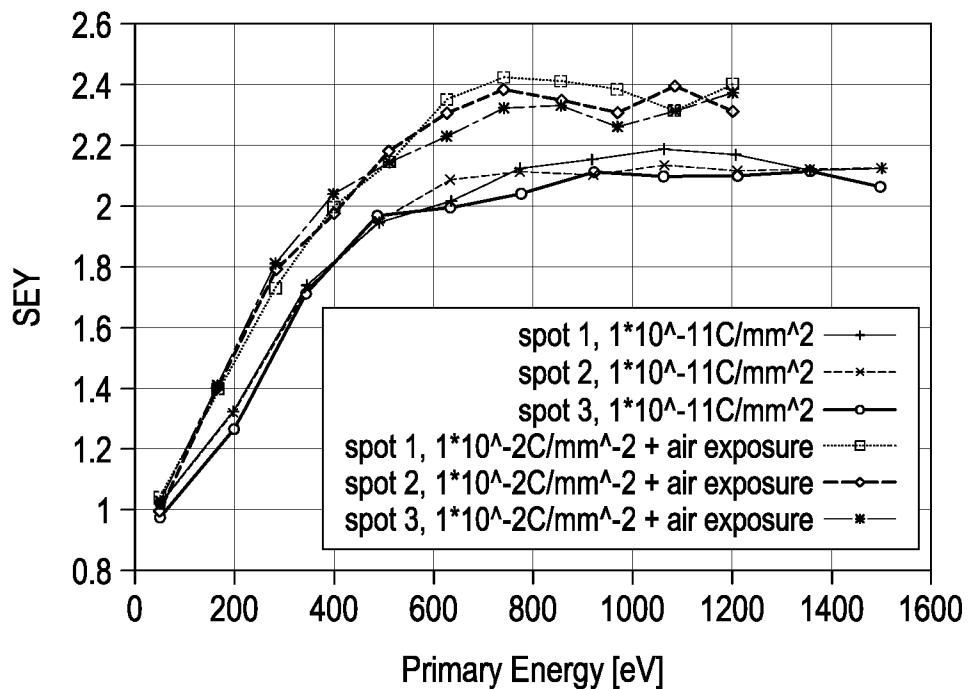


Fig. 14

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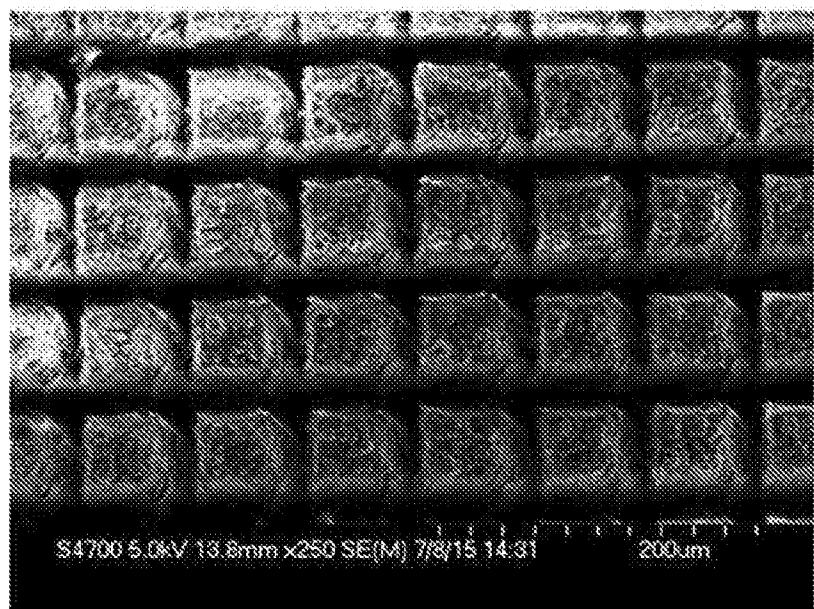


Fig. 15a

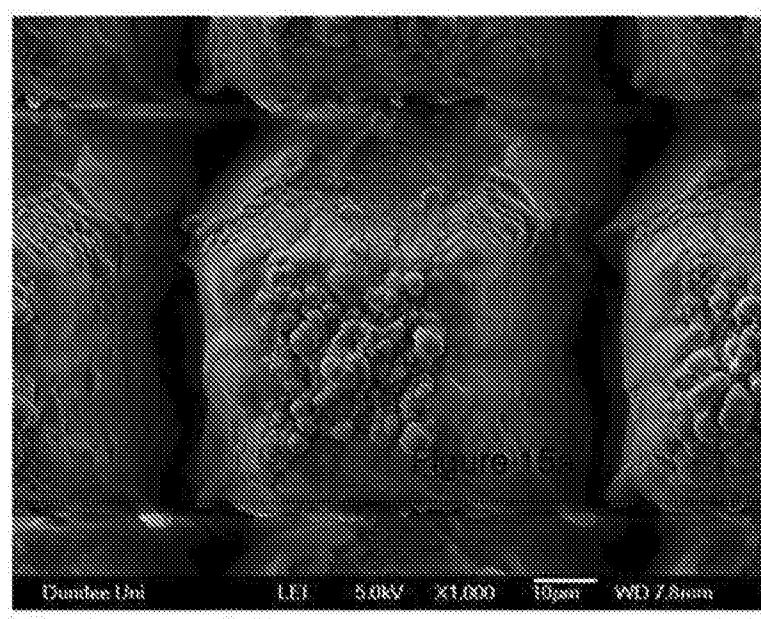


Fig. 15b

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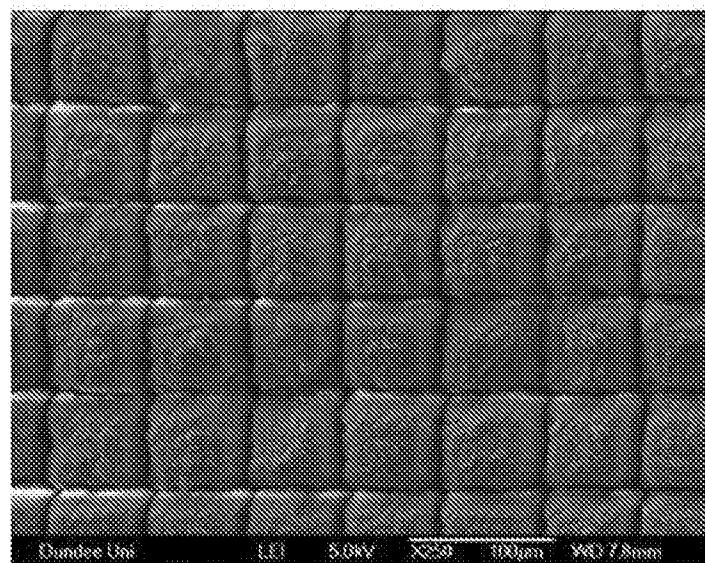
Air – 0.25 GW/cm<sup>2</sup>

Fig. 16a

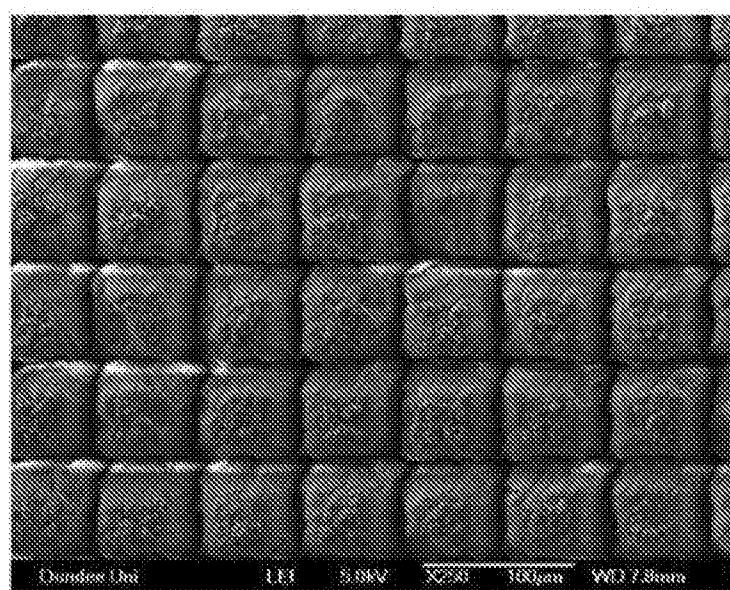
Air – 0.35 GW/cm<sup>2</sup>

Fig. 16b

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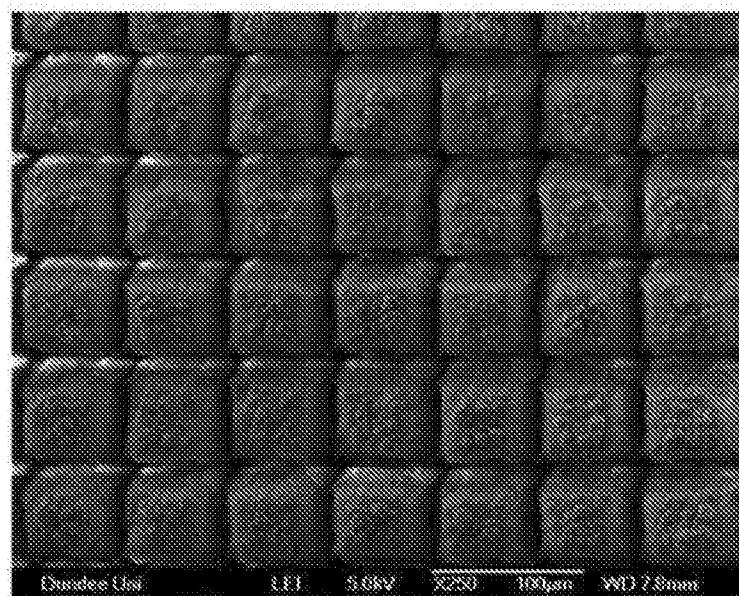
Air – 0.45 GW/cm<sup>2</sup>

Fig. 16c

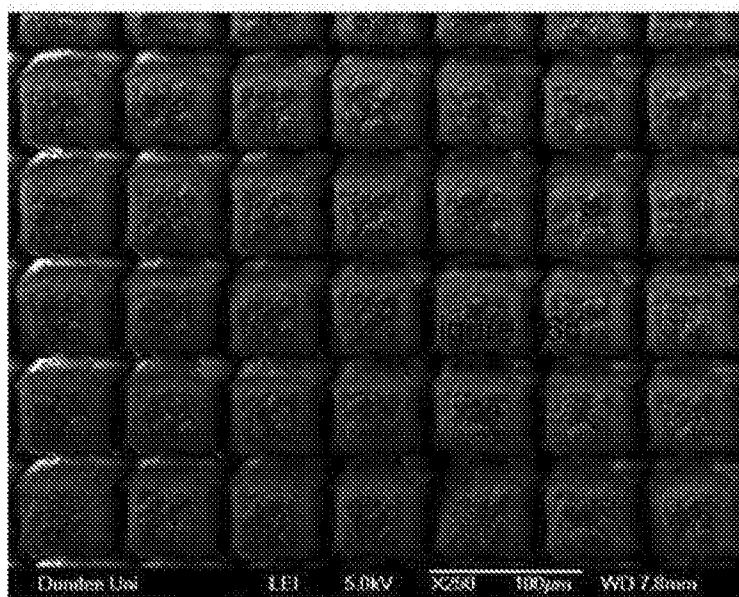
Air – 0.55 GW/cm<sup>2</sup>

Fig. 16d

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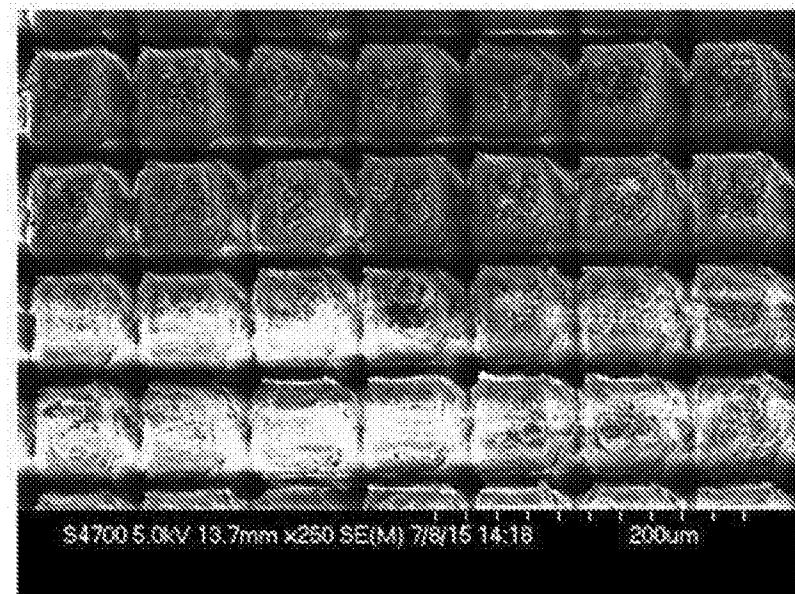
Argon – 0.6 GW/cm<sup>2</sup>

Fig. 16e

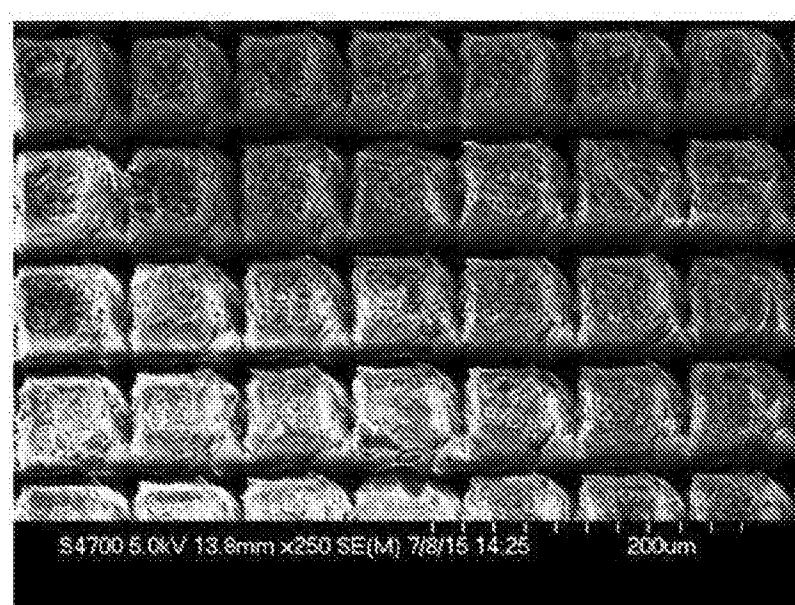
Argon – 0.65 GW/cm<sup>2</sup>

Fig. 16f

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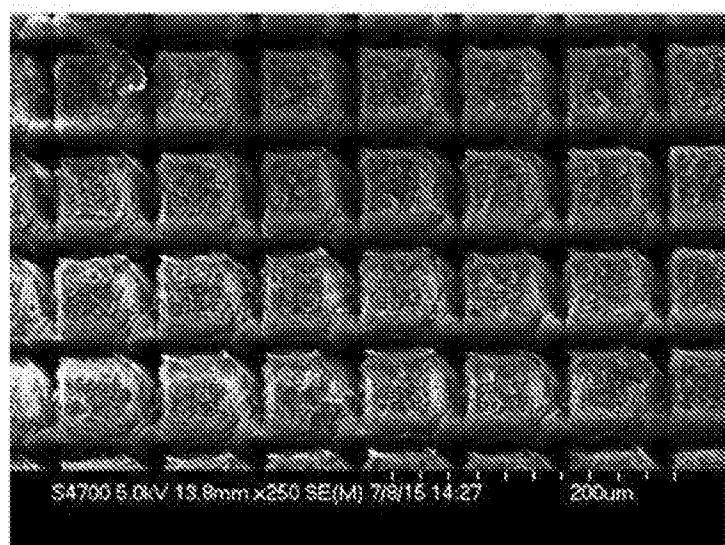
Argon – 0.7 GW/cm<sup>2</sup>

Fig. 16g

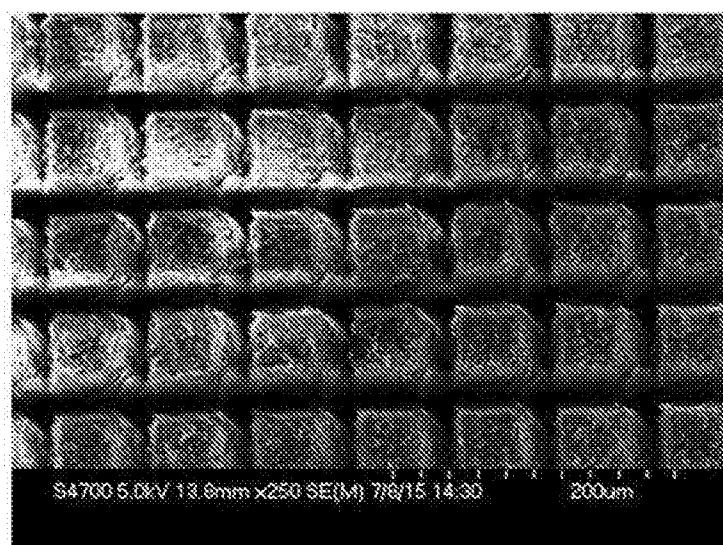
Argon – 0.75 GW/cm<sup>2</sup>

Fig. 16h

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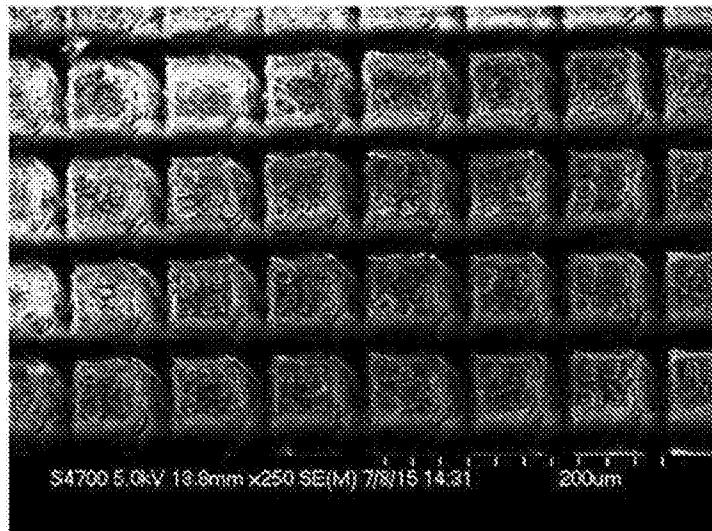
Argon – 0.8 GW/cm<sup>2</sup>

Fig. 16i

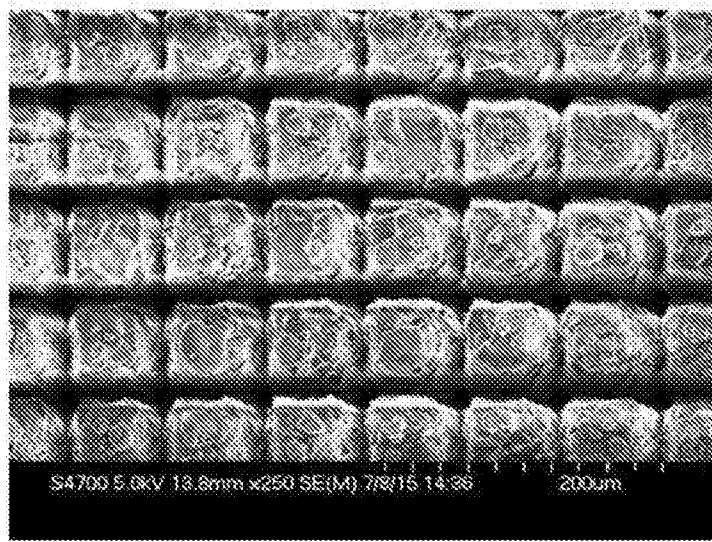
Argon – 0.85 GW/cm<sup>2</sup>

Fig. 16j

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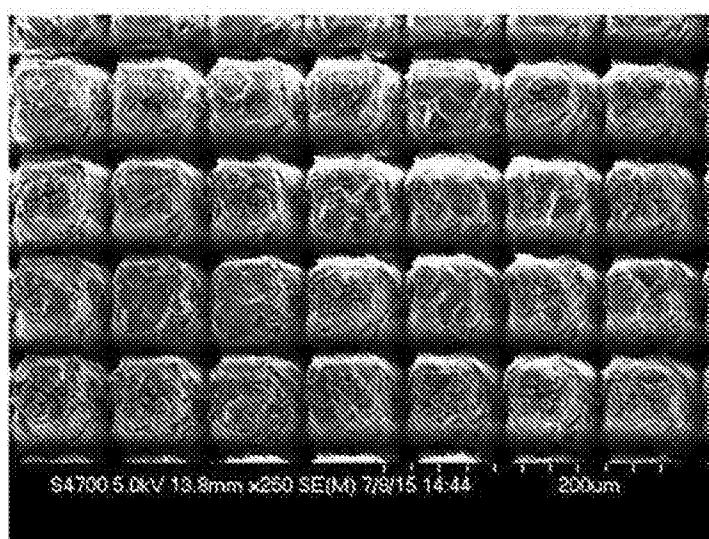
Argon – 0.9 GW/cm<sup>2</sup>

Fig. 16k

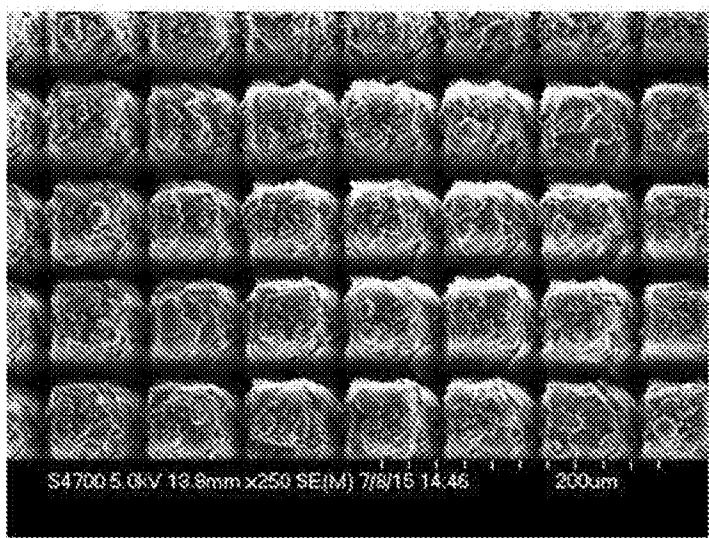
Argon – 0.95 GW/cm<sup>2</sup>

Fig. 16l

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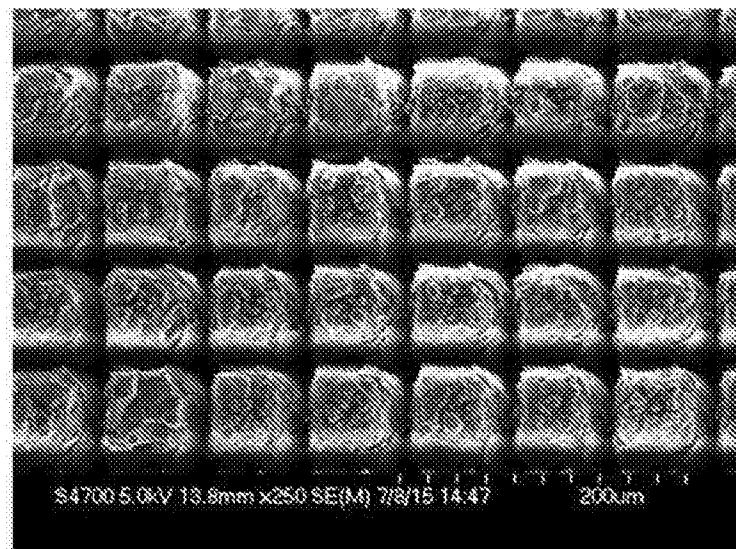
Argon – 1 GW/cm<sup>2</sup>

Fig. 16m

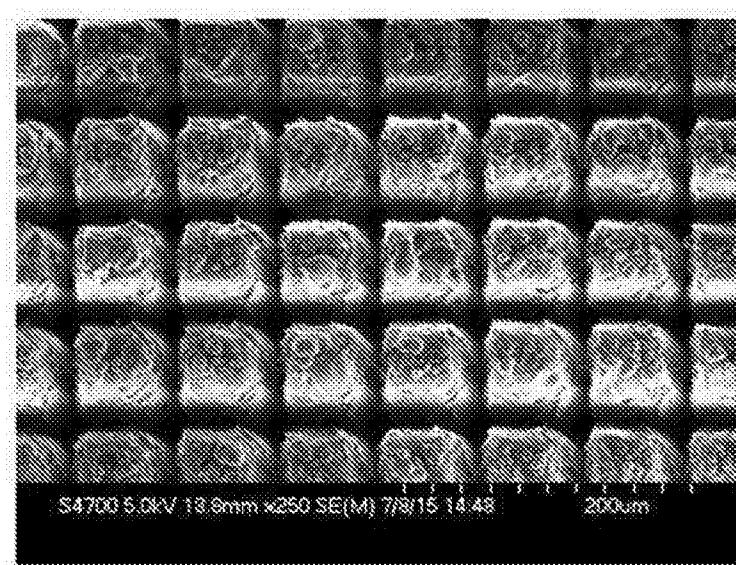
Argon – 1.5 GW/cm<sup>2</sup>

Fig. 16n

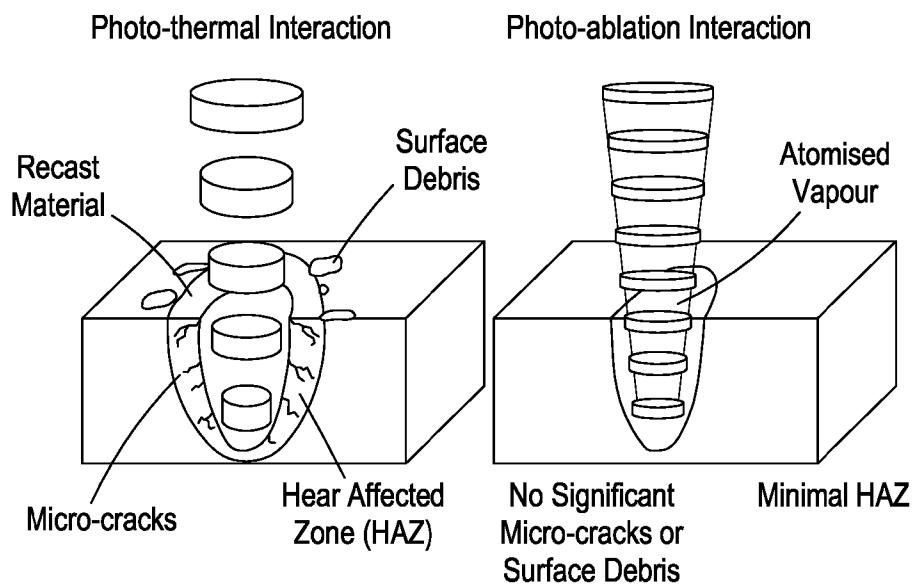


Fig. 17a

Fig. 17b

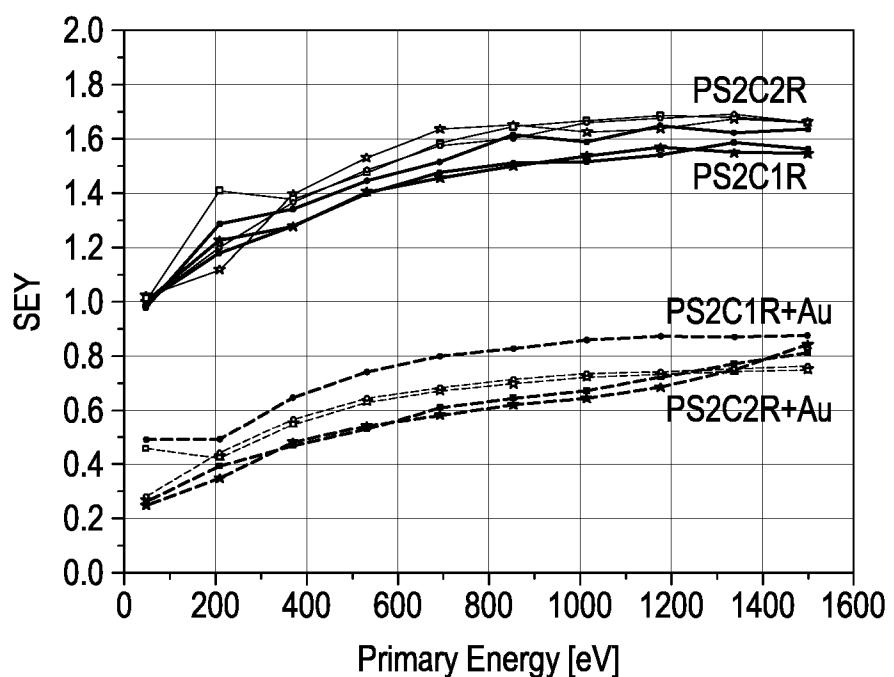


Fig. 18

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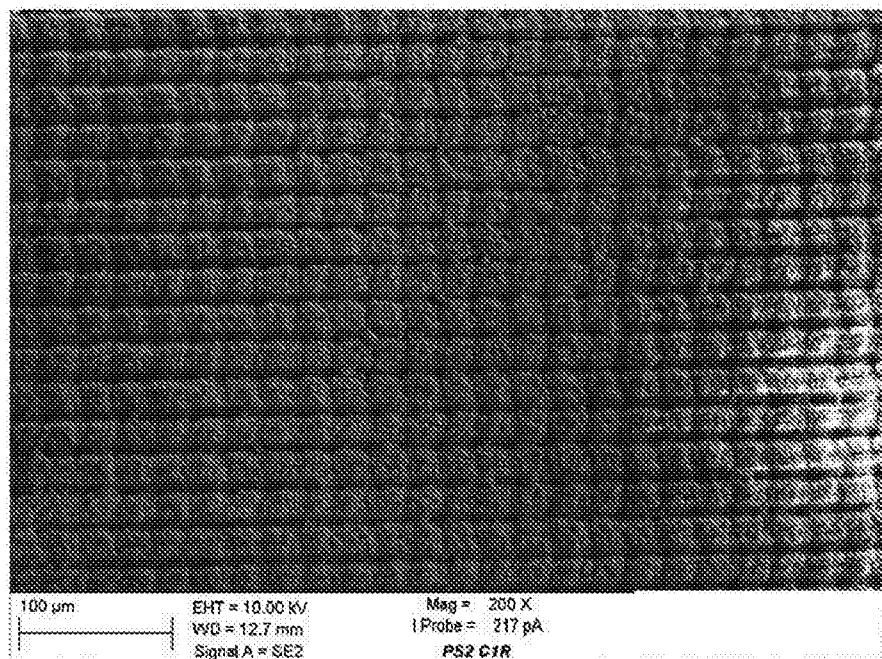


Fig. 19

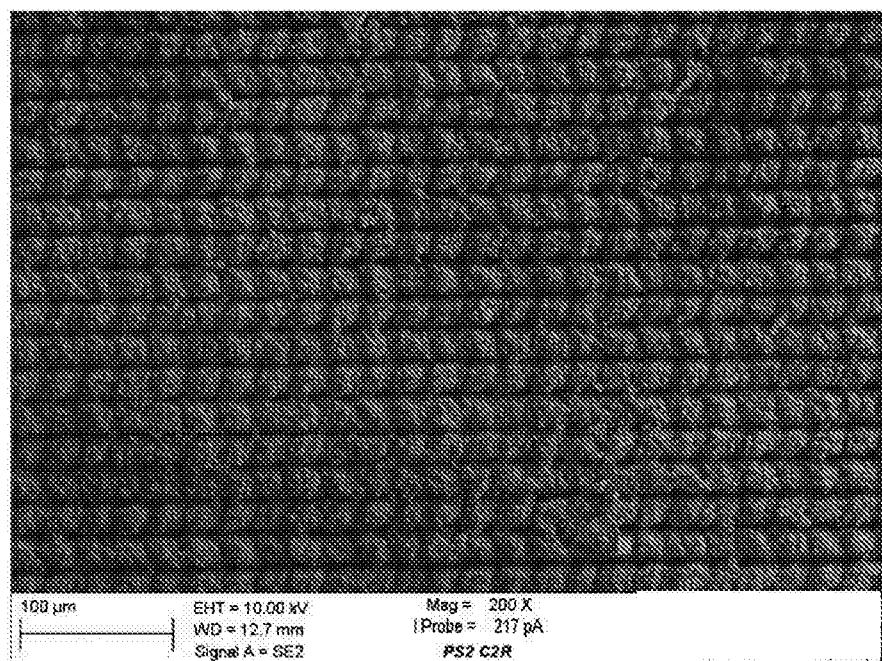


Fig. 20

# INTERNATIONAL SEARCH REPORT

International application No  
PCT/GB2017/050621

## A. CLASSIFICATION OF SUBJECT MATTER

INV.	B23K26/00	B23K26/0622	B23K26/082	B23K26/352	
ADD.	B23K103/04	B23K103/10	B23K103/12	B23K103/14	B23K101/32
	B23K101/36	B23K103/00			

According to International Patent Classification (IPC) or to both national classification and IPC

## B. FIELDS SEARCHED

Minimum documentation searched (classification system followed by classification symbols)

B23K

Documentation searched other than minimum documentation to the extent that such documents are included in the fields searched

Electronic data base consulted during the international search (name of data base and, where practicable, search terms used)

EPO-Internal, WPI Data

## C. DOCUMENTS CONSIDERED TO BE RELEVANT

Category*	Citation of document, with indication, where appropriate, of the relevant passages	Relevant to claim No.
X	US 2014/185065 A1 (L. SHAH ET AL) 3 July 2014 (2014-07-03)	31
Y	paragraphs [0004] - [0007], [0040], [0139], [0164], [0167], [0168], [0184]; figures -----	2,3,5, 9-12, 14-16,30
X	US 2013/020297 A1 (M. C. GUPTA ET AL) 24 January 2013 (2013-01-24)	1,4,6-8, 13, 17-29, 32,33
Y	paragraph [0123]; claims; figures -----	2,3,5, 9-12, 14-16,30
X	JP 2002 287191 A (SUMITOMO OSAKA CEMENT CO LTD) 3 October 2002 (2002-10-03)	31
A	abstract paragraphs [0024], [0041]; figures -----	1-30
		-/-



Further documents are listed in the continuation of Box C.



See patent family annex.

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"A" document defining the general state of the art which is not considered to be of particular relevance

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"L" document which may throw doubts on priority claim(s) or which is cited to establish the publication date of another citation or other special reason (as specified)

"O" document referring to an oral disclosure, use, exhibition or other means

"P" document published prior to the international filing date but later than the priority date claimed

"T" later document published after the international filing date or priority date and not in conflict with the application but cited to understand the principle or theory underlying the invention

"X" document of particular relevance; the claimed invention cannot be considered novel or cannot be considered to involve an inventive step when the document is taken alone

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Date of the actual completion of the international search

30 June 2017

Date of mailing of the international search report

13/07/2017

Name and mailing address of the ISA/

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NL - 2280 HV Rijswijk  
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Fax: (+31-70) 340-3016

Authorized officer

Jeggy, Thierry

**INTERNATIONAL SEARCH REPORT**International application No  
PCT/GB2017/050621

## C(Continuation). DOCUMENTS CONSIDERED TO BE RELEVANT

Category*	Citation of document, with indication, where appropriate, of the relevant passages	Relevant to claim No.
X	US 2007/199927 A1 (B. GU ET AL) 30 August 2007 (2007-08-30) paragraphs [0159], [0169] - [0174]; claim 20; figures -----	31
A		1

**INTERNATIONAL SEARCH REPORT**

Information on patent family members

International application No

PCT/GB2017/050621

Patent document cited in search report	Publication date	Patent family member(s)		Publication date
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US 2007199927	A1 30-08-2007	US 2007199927	A1	30-08-2007
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